

## **SHARC Processor**

# ADSP-21371/ADSP-21375

#### **SUMMARY**

High performance 32-bit/40-bit floating point processor optimized for high performance audio processing Single-instruction, multiple-data (SIMD) computational architecture

On-chip memory, ADSP-21371—1M bit of on-chip SRAM and a dedicated 4M bit of on-chip mask-programmable ROM

On-chip memory, ADSP-21375—0.5M bit of on-chip SRAM and a dedicated 2M bit of on-chip mask-programmable ROM

Code compatible with all other members of the SHARC family The ADSP-21371/ADSP-21375 processors are available with a 266 MHz core instruction rate with unique audiocentric peripherals such as the digital applications interface, serial ports, precision clock generators, and more. For complete ordering information, see Ordering Guide on Page 51.

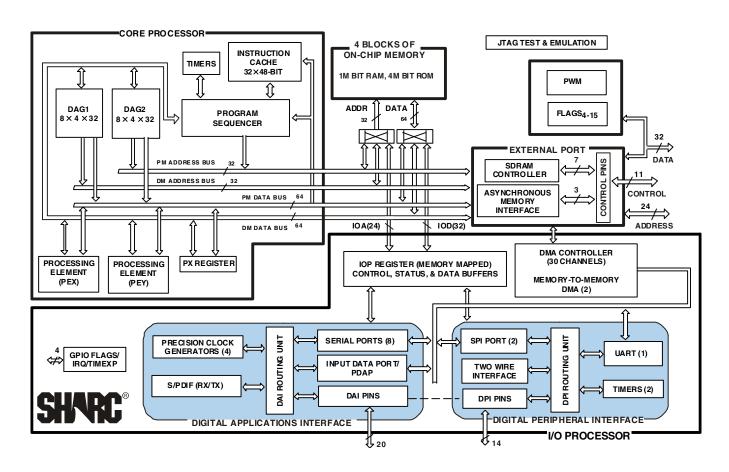


Figure 1. ADSP-21371 Functional Block Diagram

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### **KEY FEATURES—PROCESSOR CORE**

At 266 MHz (3.75 ns) core instruction rate, the ADSP-21371/ ADSP-21375 performs 1.596 GFLOPs/533 MMACs

ADSP-21371—1M bit on-chip SRAM for simultaneous access by the core processor and DMA; 4M bit on-chip, mask-programmable ROM

ADSP-21375—0.5M bit on-chip SRAM for simultaneous access by the core processor and DMA; 2M bit on-chip, mask-programmable ROM

Dual data address generators (DAGs) with modulo and bitreverse addressing

Zero-overhead looping with single-cycle loop setup, providing efficient program sequencing

Single instruction multiple data (SIMD) architecture provides
Two computational processing elements

**Concurrent execution** 

Code compatibility with other SHARC family members at the assembly level

Parallelism in buses and computational units allows single cycle executions (with or without SIMD) of a multiply operation, an ALU operation, a dual memory read or write, and an instruction fetch

Transfers between memory and core at a sustained 4.25G bytes/second bandwidth at 266 MHz core instruction rate

#### INPUT/OUTPUT FEATURES

ADSP-21371—DMA controller supports

32 DMA channels for transfers between ADSP-21371 internal memory and a variety of peripherals

32-bit DMA transfers at peripheral clock speed, in parallel with full-speed processor execution

ADSP-21371—32-bit wide external port provides glueless connection to both synchronous (SDRAM) and asynchronous memory devices

Programmable wait state options: 2 to 31 SDCLK cycles
Delay-line DMA engine maintains circular buffers in
external memory with tap/offset based reads

SDRAM accesses at 133 MHz and asynchronous accesses at 44.4 MHz

4 memory select lines allows multiple external memory devices

Digital audio interface (DAI) includes eight serial ports (ADSP-21371), four precision clock generators, an input data port, an S/PDIF transceiver, and a signal routing unit

Digital peripheral interface (DPI) includes, two timers, one UART, two SPI ports, and a 2-wire interface port

Outputs of PCGs A and B can be routed through DAI pin Outputs of PCGs C and D can be driven on to DAI as well as DPI pins

Eight dual data line serial ports (ADSP-21371) that operate at up to 50 Mbps on each data line — each has a clock, frame sync, and two data lines that can be configured as either a receiver or transmitter pair

TDM support for telecommunications interfaces including 128 TDM channel support for newer telephony interfaces such as H.100/H.110

Up to 16 TDM stream support, each with 128 channels per frame (ADSP-21371)

Companding selection on a per channel basis in TDM mode Input data port, configurable as eight channels of serial data or seven channels of serial data and up to a 20-bit wide parallel data channel (ADSP-21371)

Signal routing unit provides configurable and flexible connections between the various peripherals and the DAI/DPI components

2 muxed flag/IRQ lines

1 muxed flag/IRQ/MS pin

1 muxed flag/Timer expired line /MS pin

ADSP-21371—S/PDIF-compatible digital audio receiver/transmitter supports EIAJ CP-340 (CP-1201), IEC-958, AES/EBU standards

Left-justified, I<sup>2</sup>S or right-justified serial data input with 16-, 18-, 20-, or 24-bit word widths (transmitter)

**Pulse-width modulation provides** 

16 PWM outputs configured as four groups of four outputs supports center-aligned or edge-aligned PWM waveforms

**ROM-based security features include** 

JTAG access to memory permitted with a 64-bit key Protected memory regions that can be assigned to limit access under program control to sensitive code

PLL has a wide variety of software and hardware multiplier/divider ratios

Newly introduced "Running Reset" feature that allows a reset of the processor core and peripherals, but without resetting the PLL and SDRAM controller or performing a boot

Dual voltage: 3.3 V I/O, 1.2 V core

Available in 208-lead MQFP package (see Ordering Guide on Page 51)

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| 3/08—Rev. 0 to Rev. A                                  |
| Added ADSP-21375. ADSP-21371/ADSP-21375 Specifications |

### **GENERAL DESCRIPTION**

The ADSP-21371/ADSP-21375 SHARC® processors are members of the SIMD SHARC family of DSPs that feature Analog Devices' Super Harvard Architecture. The ADSP-21371/ADSP-21375 are source code compatible with the ADSP-2126x, ADSP-2136x, and ADSP-2116x DSPs as well as with first generation ADSP-2106x SHARC processors in SISD (single-instruction, single-data) mode. The ADSP-21371/ADSP-21375 processors are 32-bit/40-bit floating point processors optimized for high performance automotive audio applications with its large on-chip SRAM and mask-programmable ROM, multiple internal buses to eliminate I/O bottlenecks, and an innovative digital applications interface (DAI).

As shown in the functional block diagram on Page 1, the ADSP-21371/ADSP-21375 processors use two computational units to deliver a significant performance increase over the previous SHARC processors on a range of DSP algorithms. Fabricated in a state-of-the-art, high speed, CMOS process, the ADSP-21371/ADSP-21375 processors achieve an instruction cycle time of 3.75 ns at 266 MHz. With its SIMD computational hardware, the ADSP-21371/ADSP-21375 processors can perform 1.596 GFLOPS running at 266 MHz.

Table 1 shows performance benchmarks for the ADSP-21371/ ADSP-21375 processors.

Table 1. ADSP-21371/ADSP-21375 Benchmarks (at 266 MHz)

| Benchmark Algorithm                             | Speed<br>(at 266 MHz) |
|---|-----------------------|
| 1024 Point Complex FFT (Radix 4, With Reversal) | 34.5 μs               |
| FIR Filter (per Tap) <sup>1</sup>               | 1.88 ns               |
| IIR Filter (per Biquad) <sup>1</sup>            | 7.5 ns                |
| Matrix Multiply (Pipelined)                     |                       |
| $[3 \times 3] \times [3 \times 1]$              | 16.91 ns              |
| $[4 \times 4] \times [4 \times 1]$              | 30.07 ns              |
| Divide (y/x)                                    | 13.1 ns               |
| Inverse Square Root                             | 20.4 ns               |

<sup>&</sup>lt;sup>1</sup>Assumes two files in multichannel SIMD mode

The ADSP-21371/ADSP-21375 processors continue SHARC's industry-leading standards of integration for DSPs, combining a high performance 32-bit DSP core with integrated, on-chip system features.

The block diagram of the ADSP-21371/ADSP-21375 on Page 1 illustrates the following architectural features:

- Two processing elements, each of which comprises an ALU, multiplier, shifter, and data register file
- Data address generators (DAG1, DAG2)
- · Program sequencer with instruction cache
- PM and DM buses capable of supporting four 32-bit data transfers between memory and the core at every core processor cycle

- Two programmable interval timers with external event counter capabilities
- On-chip SRAM (1M bit, ADSP-21371; 0.5M bit, ADSP-21375)
- On-chip mask-programmable ROM (4M bit, ADSP-21371; 2 M bit, ADSP-21375)
- JTAG test access port

The block diagram of the ADSP-21371/ADSP-21375 on Page 1 also illustrates the following architectural features:

- DMA controller
- ADSP-21371—Digital applications interface that includes four precision clock generators (PCG), an S/PDIF-compatible digital audio receiver/transmitter, an input data port (IDP), eight serial ports, eight serial interfaces, a 20-bit parallel input port (PDAP), and a flexible signal routing unit (DAI SRU).
- Digital peripheral interface that includes two timers, one UART, two serial peripheral interfaces (SPI), a 2-wire interface (TWI), and a flexible signal routing unit (DPI SRU).

# ADSP-21371/ADSP-21375 FAMILY CORE ARCHITECTURE

The ADSP-21371/ADSP-21375 processors are code compatible at the assembly level with the ADSP-2136x, ADSP-2126x, ADSP-21160, and ADSP-21161, and with the first generation ADSP-2106x SHARC processors. The ADSP-21371/ADSP-21375 processors share architectural features with the ADSP-2126x, ADSP-2136x, and ADSP-2116x SIMD SHARC processors, as detailed in the following sections.

### **SIMD Computational Engine**

The ADSP-21371/ADSP-21375 processors contain two computational processing elements that operate as a single-instruction, multiple-data (SIMD) engine. The processing elements are referred to as PEX and PEY and each contains an ALU, multiplier, shifter, and register file. PEX is always active, and PEY may be enabled by setting the PEYEN mode bit in the MODE1 register. When this mode is enabled, the same instruction is executed in both processing elements, but each processing element operates on different data. This architecture is efficient at executing math intensive DSP algorithms.

Entering SIMD mode also has an effect on the way data is transferred between memory and the processing elements. When in SIMD mode, twice the data bandwidth is required to sustain computational operation in the processing elements. Because of this requirement, entering SIMD mode also doubles the bandwidth between memory and the processing elements. When using the DAGs to transfer data in SIMD mode, two data values are transferred with each access of memory or the register file.

### **Independent, Parallel Computation Units**

Within each processing element is a set of computational units. The computational units consist of an arithmetic/logic unit (ALU), multiplier, and shifter. These units perform all operations in a single cycle. The three units within each processing element are arranged in parallel, maximizing computational throughput. Single multifunction instructions execute parallel ALU and multiplier operations. In SIMD mode, the parallel ALU and multiplier operations occur in both processing elements. These computation units support IEEE 32-bit single-precision floating-point, 40-bit extended precision floating-point, and 32-bit fixed-point data formats.

### **Data Register File**

A general-purpose data register file is contained in each processing element. The register files transfer data between the computation units and the data buses, and store intermediate results. These 10-port, 32-register (16 primary, 16 secondary) register files, combined with the ADSP-2136x enhanced Harvard architecture, allow unconstrained data flow between computation units and internal memory. The registers in PEX are referred to as R0-R15 and in PEY as S0-S15.

### Single-Cycle Fetch of Instruction and Four Operands

The ADSP-21371/ADSP-21375 processors feature an enhanced Harvard architecture in which the data memory (DM) bus transfers data and the program memory (PM) bus transfers both instructions and data (see Figure 1 on Page 1). With the ADSP-21371/ADSP-21375's separate program and data memory buses and on-chip instruction cache, the processor can simultaneously fetch four operands (two over each data bus) and one instruction (from the cache), all in a single cycle.

### **Instruction Cache**

The ADSP-21371/ADSP-21375 processors include an on-chip instruction cache that enables three-bus operation for fetching an instruction and four data values. The cache is selective—only the instructions whose fetches conflict with PM bus data accesses are cached. This cache allows full speed execution of core, looped operations such as digital filter multiply-accumulates, and FFT butterfly processing.

# Data Address Generators with Zero-Overhead Hardware Circular Buffer Support

The ADSP-21371/ADSP-21375's two data address generators (DAGs) are used for indirect addressing and implementing circular data buffers in hardware. Circular buffers allow efficient programming of delay lines and other data structures required in digital signal processing, and are commonly used in digital filters and Fourier transforms. The two DAGs of the ADSP-21371/ADSP-21375 processors contain sufficient registers to allow the creation of up to 32 circular buffers (16 primary register sets, 16 secondary). The DAGs automatically handle address pointer wraparound, reduce overhead, increase performance, and simplify implementation. Circular buffers can start and end at any memory location.

#### Flexible Instruction Set

The 48-bit instruction word accommodates a variety of parallel operations, for concise programming. For example, the ADSP-21371/ADSP-21375 can conditionally execute a multiply, an add, and a subtract in both processing elements while branching and fetching up to four 32-bit values from memory—all in a single instruction.

### **ADSP-21371/ADSP-21375 MEMORY**

The ADSP-21371/ADSP-21375 processors add the following architectural features to the SIMD SHARC family core.

### **On-Chip Memory**

The ADSP-21371 processor contains 1 megabit of internal RAM and four megabits of internal mask-programmable ROM. Each block can be configured for different combinations of code and data storage (see Table 3 on Page 7). Each memory block supports single-cycle, independent accesses by the core processor and I/O processor. The ADSP-21371/ ADSP-21375 memory architecture, in combination with its separate on-chip buses, allow two data transfers from the core and one from the I/O processor, in a single cycle.

The ADSP-21371's SRAM can be configured as a maximum of 32k words of 32-bit data, 64k words of 16-bit data, 21.3k words of 48-bit instructions (or 40-bit data), or combinations of different word sizes up to 1 megabit. All of the memory can be accessed as 16-bit, 32-bit, 48-bit, or 64-bit words. A 16-bit floating-point storage format is supported that effectively doubles the amount of data that may be stored on-chip. Conversion between the 32-bit floating-point and 16-bit floating-point formats is performed in a single instruction. While each memory block can store combinations of code and data, accesses are most efficient when one block stores data using the DM bus for transfers, and the other block stores instructions and data using the PM bus for transfers.

Table 2. ADSP-21371 Internal Memory Space

| IOP Registers 0x0000 0000           | 0-0x0003 FFFF  |                                  |                                  |
|-------------------------------------|--|----------------------------------|----------------------------------|
| Long Word (64 bits)                 | Extended Precision Normal or<br>Instruction Word (48 bits) | Normal Word (32 bits)            | Short Word (16 bits)             |
| BLOCK 0 ROM                         | BLOCK 0 ROM  | BLOCK 0 ROM                      | BLOCK 0 ROM                      |
| 0x0004 0000–0x0004 7FFF             | 0x0008 0000-0x0008 AAA9                                    | 0x0008 0000-0x0008 FFFF          | 0x0010 0000–0x0011 FFFF          |
| Reserved<br>0x0004 8000–0x0004 BFFF | Reserved<br>0x0008 AAAA-0x0008 FFFF                        | Reserved 0x0009 0000–0x0009 7FFF | Reserved 0x0012 0000–0x0012 FFFF |
| BLOCK 0 RAM                         | BLOCK 0 RAM  | BLOCK 0 RAM                      | BLOCK 0 RAM                      |
| 0x0004 C000–0x0004 CFFF             | 0x0009 0000-0x0009 1554                                    | 0x0009 8000-0x0009 9FFF          | 0x0013 0000-0x0013 3FFF          |
| Reserved                            | Reserved   | Reserved                         | Reserved 0x0013 4000–0x0013 FFFF |
| 0x0004 D000–0x0004 FFFF             | 0x0009 1555–0x0009 FFFF                                    | 0x0009 A000–0x0009 FFFF          |                                  |
| BLOCK 1 ROM                         | BLOCK 1 ROM  | BLOCK 1 ROM                      | BLOCK 1 ROM                      |
| 0x0005 0000–0x0005 7FFF             | 0x000A 0000-0x000A AAA9                                    | 0x000A 0000–0x000A FFFF          | 0x0014 0000–0x0015 FFFF          |
| Reserved<br>0x0005 8000–0x0005 BFFF | Reserved<br>0x000A AAAA-0x000A FFFF                        | Reserved 0x000B 0000–0x000B 7FFF | Reserved 0x0016 0000–0x0016 FFFF |
| BLOCK 1 RAM                         | BLOCK 1 RAM  | BLOCK 1 RAM                      | BLOCK 1 RAM                      |
| 0x0005 C000–0x0005 CFFF             | 0x000B 0000-0x000B 1554                                    | 0x000B 8000-0x000B 9FFF          | 0x0017 0000–0x0017 3FFF          |
| Reserved                            | Reserved   | Reserved                         | Reserved                         |
| 0x0005 D000–0x0005 FFFF             | 0x000B 1555–0x000B FFFF                                    | 0x000B A000–0x000B FFFF          | 0x0017 4000–0x0017 FFFF          |
| BLOCK 2 RAM                         | BLOCK 2 RAM  | BLOCK 2 RAM                      | BLOCK 2 RAM                      |
| 0x0006 0000–0x0006 0FFF             | 0x000C 0000-0x000C 1554                                    | 0x000C 0000–0x000C 1FFF          | 0x0018 0000-0x0018 3FFF          |
| Reserved                            | Reserved   | Reserved                         | Reserved 0x0018 4000–0x001B FFFF |
| 0x0006 1000–0x0006 FFFF             | 0x000C 1555–0x000D FFFF                                    | 0x000C 2000–0x000D FFFF          |                                  |
| BLOCK 3 RAM                         | BLOCK 3 RAM  | BLOCK 3 RAM                      | BLOCK 3 RAM                      |
| 0x0007 0000–0x0007 0FFF             | 0x000E 0000-0x000E 1554                                    | 0x000E 0000–0x000E 1FFF          | 0x001C 0000–0x001C 3FFF          |
| Reserved                            | Reserved   | Reserved                         | Reserved                         |
| 0x0007 1000–0x0007 FFFF             | 0x000E 1555–0x000F FFFF                                    | 0x000E 2000–0x000F FFFF          | 0x001C 4000–0x001F FFFF          |

Using the DM bus and PM buses, with one bus dedicated to a memory block, assures single-cycle execution with two data transfers. In this case, the instruction must be available in the cache.

### **EXTERNAL MEMORY**

The external port on the ADSP-21371/ADSP-21375 SHARC processors provide a high performance, glueless interface to a wide variety of industry-standard memory devices. The 32-bit wide bus (ADSP-21371) may be used to interface to synchronous and/or asynchronous memory devices through the use of

Table 3. ADSP-21375 Internal Memory Space

| IOP Registers 0x0000 0000-0x0003 FFFF |  |                                  |                                  |
|---------------------------------------|--|----------------------------------|----------------------------------|
| Long Word (64 bits)                   | Extended Precision Normal or<br>Instruction Word (48 bits) | Normal Word (32 bits)            | Short Word (16 bits)             |
| BLOCK 0 ROM                           | BLOCK 0 ROM  | BLOCK 0 ROM                      | BLOCK 0 ROM                      |
| 0x0004 0000-0x0004 3FFF               | 0x0008 0000-0x0008 5554                                    | 0x0008 0000-0x0008 7FFF          | 0x0010 0000-0x0010 FFFF          |
| Reserved                              | Reserved   | Reserved                         | Reserved                         |
| 0x0004 4000–0x0004 BFFF               | 0x0008 5555–0x0008 FFFF                                    | 0x0008 8000–0x0009 7FFF          | 0x0011 0000–0x0012 FFFF          |
| BLOCK 0 RAM                           | BLOCK 0 RAM  | BLOCK 0 RAM                      | BLOCK 0 RAM                      |
| 0x0004 C000-0x0004 C7FF               | 0x0009 0000-0x0009 0AAA                                    | 0x0009 8000-0x0009 8FFF          | 0x0013 0000-0x0013 1FFF          |
| Reserved                              | Reserved   | Reserved                         | Reserved 0x0013 2000–0x0013 FFFF |
| 0x0004 C800–0x0004 FFFF               | 0x0009 0AAB-0x0009 FFFF                                    | 0x0009 9000–0x0009 FFFF          |                                  |
| BLOCK 1 ROM                           | BLOCK 1 ROM  | BLOCK 1 ROM                      | BLOCK 1 ROM                      |
| 0x0005 0000–0x0005 3FFF               | 0x000A 0000–0x000A 5554                                    | 0x000A 0000-0x000A 7FFF          | 0x0014 0000-0x0014 FFFF          |
| Reserved                              | Reserved   | Reserved                         | Reserved                         |
| 0x0005 4000–0x0005 BFFF               | 0x000A 5555–0x000A FFFF                                    | 0x000A 8000–0x000B 7FFF          | 0x0015 0000–0x0016 FFFF          |
| BLOCK 1 RAM                           | BLOCK 1 RAM  | BLOCK 1 RAM                      | BLOCK 1 RAM                      |
| 0x0005 C000–0x0005 C7FF               | 0x000B 0000-0x000B 0AAA                                    | 0x000B 8000-0x000B 8FFF          | 0x0017 0000-0x0017 1FFF          |
| Reserved<br>0x0005 C800–0x0005 FFFF   | Reserved<br>0x000B 0AAB-0x000B FFFF                        | Reserved 0x000B 9000–0x000B FFFF | Reserved 0x0017 2000–0x0017 FFFF |
| BLOCK 2 RAM                           | BLOCK 2 RAM  | BLOCK 2 RAM                      | BLOCK 2 RAM                      |
| 0x0006 0000-0x0006 07FF               | 0x000C 0000-0x000C 0AAA                                    | 0x000C 0000-0x000C 0FFF          | 0x0018 0000-0x0018 1FFF          |
| Reserved                              | Reserved   | Reserved                         | Reserved 0x0018 2000–0x001B FFFF |
| 0x0006 0800–0x0006 FFFF               | 0x000C 0AAB-0x000D FFFF                                    | 0x000C 1000–0x000D FFFF          |                                  |
| BLOCK 3 RAM                           | BLOCK 3 RAM  | BLOCK 3 RAM                      | BLOCK 3 RAM                      |
| 0x0007 0000–0x0007 07FF               | 0x000E 0000-0x000E 0AAA                                    | 0x000E 0000-0x000E 0FFF          | 0x001C 0000-0x001C 1FFF          |
| Reserved                              | Reserved   | Reserved                         | Reserved                         |
| 0x0007 0800–0x0007 FFFF               | 0x000E 0AAB-0x000F FFFF                                    | 0x000E 1000–0x000F FFFF          | 0x001C 2000–0x001F FFFF          |

its separate internal memory controllers: the first is an SDRAM controller for connection of industry-standard synchronous DRAM devices and DIMMs (dual inline memory module), while the second is an asynchronous memory controller intended to interface to a variety of memory devices. Four memory select pins enable up to four separate devices to coexist, supporting any desired combination of synchronous and asynchronous device types. Non SDRAM external memory address space is shown in Table 4.

### **External Memory Execution**

In the ADSP-21371/ADSP-21375, the program sequencer can execute code directly from external memory bank 0 (SRAM, SDRAM). This allows a reduction in internal memory size, thereby reducing the die area. With external execution, programs run at slower speeds since 48-bit instructions are fetched in parts from a 16-bit external bus coupled with the inherent latency of fetching instructions from SDRAM. Fetching instructions from external memory generally takes 1.5 peripheral clock cycles per instruction.

#### **SDRAM Controller**

The SDRAM controller provides an interface to up to four separate banks of industry-standard SDRAM devices or DIMMs. Fully compliant with the SDRAM standard, each bank can has its own memory select line  $(\overline{MSO}-\overline{MS3})$ , and can be configured to contain between 16M bytes and 256M bytes of memory. SDRAM external memory address space is shown in Table 5.

The controller maintains all of the banks as a contiguous address space so that the processor sees this as a single address space, even if different size devices are used in the different banks.

A set of programmable timing parameters is available to configure the SDRAM banks to support slower memory devices. The memory banks can be configured as 16 bits wide or as 32 bits wide.

The SDRAM controller address, data, clock, and command pins can drive loads up to 30 pF. For larger memory systems, the SDRAM controller external buffer timing should be selected and external buffering should be provided so that the load on the SDRAM controller pins does not exceed 30 pF.

Table 4. External Memory for Non SDRAM Addresses

| Bank   | Size in<br>Words | Address Range           |
|--------|------------------|-------------------------|
| Bank 0 | 14M              | 0x0020 0000-0x00FF FFFF |
| Bank 1 | 16M              | 0x0400 0000-0x04FF FFFF |
| Bank 2 | 16M              | 0x0800 0000-0x08FF FFFF |
| Bank 3 | 16M              | 0x0C00 0000-0x0CFF FFFF |

Table 5. External Memory for SDRAM Addresses

| Bank   | Size in<br>Words | Address Range           |
|--------|------------------|-------------------------|
| Bank 0 | 62M              | 0x0020 0000-0x03FF FFFF |
| Bank 1 | 64M              | 0x0400 0000-0x07FF FFFF |
| Bank 2 | 64M              | 0x0800 0000-0x0BFF FFFF |
| Bank 3 | 64M              | 0x0C00 0000-0x0FFF FFFF |

Note that the external memory bank addresses shown are for normal word accesses. If 48-bit instructions are placed in any such bank (with two instructions packed into three 32-bit locations), then care must be taken to map data buffers in the same bank. For example, if 2k instructions are placed starting at the bank 0 base address (0x0020 0000), then the data buffers can be placed starting at an address that is offset by 3k words (0x0020 0C00).

### **Asynchronous Controller**

The asynchronous memory controller provides a configurable interface for up to four separate banks of memory or I/O devices. Each bank can be independently programmed with different timing parameters, enabling connection to a wide variety of memory devices including SRAM, ROM, flash, and EPROM, as well as I/O devices that interface with standard memory control lines. Bank 0 occupies a 14.7M word window and banks 1, 2, and 3 occupy a 16M word window in the processor's address space but, if not fully populated, these windows are not made contiguous by the memory controller logic. The banks can also be configured as 8-bit or 16-bit wide buses for ease of interfacing to a range of memories and I/O devices tailored either to high performance or to low cost and power.

The asynchronous memory controller is capable of a maximum throughput of 176 Mbps using a 44 MHz external bus speed. Other features include 8- to 32-bit and 16- to 32-bit packing and unpacking, booting from bank select 1, and support for delay line DMA.

# ADSP-21371/ADSP-21375 INPUT/OUTPUT FEATURES

The ADSP-21371/ADSP-21375 I/O processor provides 32 channels of DMA, as well as an extensive set of peripherals. These include a 20-lead digital applications interface, which controls

- Eight serial ports (ADSP-21371)
- S/PDIF receiver/transmitter (ADSP-21371)
- Four precision clock generators
- Input data port/parallel data acquisition port (ADSP-21371)

The ADSP-21371/ADSP-21375 processor also contains a 14-lead digital peripheral interface, which controls

- Two general-purpose timers
- Two serial peripheral interfaces
- One universal asynchronous receiver/transmitter (UART)
- An I<sup>2</sup>C<sup>®</sup>-compatible 2-wire interface

### **DMA Controller**

The ADSP-21371/ADSP-21375's on-chip DMA controller allows data transfers without processor intervention. The DMA controller operates independently and invisibly to the processor core, allowing DMA operations to occur while the core is simultaneously executing its program instructions. DMA transfers can occur between the ADSP-21371's internal memory and its serial ports, the SPI-compatible (serial peripheral interface) ports, the IDP (input data port), the parallel data acquisition port (PDAP) or the UART. Thirty-two channels of DMA are available on the ADSP-21371, 16 via the serial ports, eight via the input data port, two for the UART, two for the SPI interface, two for the external port, and two for memory-to-memory transfers. Programs can be downloaded to the ADSP-21371/ADSP-21375 using DMA transfers. Other DMA features include interrupt generation upon completion of DMA transfers, and DMA chaining for automatic linked DMA transfers.

### **Delay Line DMA**

The ADSP-21371/ADSP-21375 processors provide delay line DMA functionality. This allows processor reads and writes to external delay line buffers (and hence to external memory) with limited core interaction.

### **Digital Applications Interface (DAI)**

The digital applications interface (DAI) provides the ability to connect various peripherals to any of the DSP DAI pins (DAI\_P1 to DAI\_P20).

Programs make these connections using the signal routing unit (SRU), shown in Figure 1.

The SRU is a matrix routing unit (or group of multiplexers) that enables the peripherals provided by the DAI to be interconnected under software control. This allows easy use of the DAI associated peripherals for a much wider variety of applications by using a larger set of algorithms than is possible with nonconfigurable signal paths.

For the ADSP-21371, the DAI also includes eight serial ports, four precision clock generators (PCG), and an input data port (IDP). For the ADSP-21375, the DAI also includes four serial ports, four precision clock (PCG) and an input data port (IDP).

The IDP provides an additional input path to the core of the ADSP-21371 processor, configurable as either eight channels of I<sup>2</sup>S serial data, or a single 20-bit wide synchronous parallel data acquisition port.

Each data channel has its own DMA channel that is independent from the ADSP-21371/ADSP-21375's serial ports.

#### **Serial Ports**

The ADSP-21371/ADSP-21375 processors feature eight synchronous serial ports for the ADSP-21371; four synchronous serial ports for the ADSP-21375, that provide an inexpensive interface to a wide variety of digital and mixed-signal peripheral devices such as Analog Devices' AD183x family of audio codecs, ADCs, and DACs. The serial ports are made up of two data lines, a clock, and frame sync. The data lines can be programmed to either transmit or receive and each data line has a dedicated DMA channel.

For the ADSP-21371, serial ports are enabled via 16 programmable pins and simultaneous receive or transmit pins that support up to 32 transmit or 32 receive channels of audio data when all eight SPORTs are enabled, or eight duplex TDM streams of 128 channels per frame.

For the ADSP-21375, serial ports are enabled via eight programmable pins and simultaneous receive or transmit pins that support up to 16 transmit or 16 receive channels of audio data when all four SPORTs are enabled, or four duplex TDM streams of 128 channels per frame.

The serial ports operate at a maximum data rate of 50 Mbps. Serial port data can be automatically transferred to and from on-chip memory via dedicated DMA channels. Each of the serial ports can work in conjunction with another serial port to provide TDM support. One SPORT provides two transmit signals while the other SPORT provides the two receive signals. The frame sync and clock are shared.

Serial ports operate in five modes:

- Standard DSP serial mode
- Multichannel (TDM) mode with support for packed I<sup>2</sup>S mode
- I<sup>2</sup>S mode
- Packed I<sup>2</sup>S mode
- Left-justified sample pair mode

Left-justified sample pair mode is a mode where in each frame sync cycle two samples of data are transmitted/received—one sample on the high segment of the frame sync, the other on the low segment of the frame sync. Programs have control over various attributes of this mode.

Each of the serial ports supports the left-justified sample pair and  $\rm I^2S$  protocols ( $\rm I^2S$  is an industry-standard interface commonly used by audio codecs, ADCs, and DACs such as the Analog Devices AD183x family), with two data pins, allowing

four left-justified sample pair or  $I^2S$  channels (using two stereo devices) per serial port, with a maximum of up to 32  $I^2S$  channels. The serial ports permit little-endian or big-endian transmission formats and word lengths selectable from 3 bits to 32 bits. For the left-justified sample pair and  $I^2S$  modes, dataword lengths are selectable between 8 bits and 32 bits. Serial ports offer selectable synchronization and transmit modes as well as optional  $\mu$ -law or A-law companding selection on a per channel basis. Serial port clocks and frame syncs can be internally or externally generated.

The serial ports also contain frame sync error detection logic where the serial ports detect frame syncs that arrive early (for example frame syncs that arrive while the transmission/reception of the previous word is occurring). All the serial ports also share one dedicated error interrupt.

### S/PDIF-Compatible Digital Audio Receiver/Transmitter

For the ADSP-21371, the S/PDIF receiver/transmitter has no separate DMA channels. It receives audio data in serial format and converts it into a biphase encoded signal. The serial data input to the receiver/transmitter can be formatted as left justified, I<sup>2</sup>S or right justified with word widths of 16, 18, 20, or 24 bits.

For the ADSP-21371, the serial data, clock, and frame sync inputs to the S/PDIF receiver/transmitter are routed through the signal routing unit (SRU). They can come from a variety of sources such as the SPORTs, external pins, the precision clock generators (PCGs), and are controlled by the SRU control registers.

The ADSP-21375 does not have an S/PDIF-Compatible Digital Receiver/Transmitter.

### Digital Peripheral Interface (DPI)

The digital peripheral interface provides connections to two serial peripheral interface (SPI) ports, one universal asynchronous receiver-transmitter (UART), 12 flags, a 2-wire interface (TWI), and two general-purpose timers.

### Serial Peripheral Interface (Compatible)

The ADSP-21371/ADSP-21375 SHARC processors contain two serial peripheral interface (SPI) ports. The SPI is an industry-standard synchronous serial link, enabling the SPI-compatible ports of the ADSP-21371/ADSP-21375 processors to communicate with other SPI compatible devices. The SPI consists of two data pins, one device select pin, and one clock pin. It is a full-duplex synchronous serial interface, supporting both master and slave modes. The SPI port can operate in a multimaster environment by interfacing with up to four other SPI-compatible devices, either acting as a master or slave device.

The ADSP-21371/ADSP-21375 SPI-compatible peripheral implementation also features programmable baud rate and clock phase and polarities. The ADSP-21371/ADSP-21375 SPI-compatible port uses open drain drivers to support a multimaster configuration and to avoid data contention.

#### **UART Port**

The ADSP-21371/ADSP-21375 processors provide a full-duplex Universal Asynchronous Receiver/Transmitter (UART) port, which is fully compatible with PC-standard UARTs. The UART port provides a simplified UART interface to other peripherals or hosts, supporting full-duplex, DMA-supported, asynchronous transfers of serial data. The UART also has multiprocessor communication capability using 9-bit address detection. This allows it to be used in multidrop networks through the RS-485 data interface standard. The UART port also includes support for 5 to 8 data bits, 1 or 2 stop bits, and none, even, or odd parity. The UART port supports two modes of operation:

- PIO (programmed I/O) The processor sends or receives data by writing or reading I/O-mapped UART registers. The data is double-buffered on both transmit and receive.
- DMA (direct memory access) The DMA controller transfers both transmit and receive data. This reduces the number and frequency of interrupts required to transfer data to and from memory. The UART has two dedicated DMA channels, one for transmit and one for receive. These DMA channels have lower default priority than most DMA channels because of their relatively low service rates.

The UART port's baud rate, serial data format, error code generation and status, and interrupts are programmable:

- Supporting bit rates ranging from (f<sub>PCLK</sub>/1,048,576) to (f<sub>PCLK</sub>/16) bits per second.
- Supporting data formats from 7 to 12 bits per frame.
- Both transmit and receive operations can be configured to generate maskable interrupts to the processor.

In conjunction with the general-purpose timer functions, autobaud detection is supported.

#### **Timers**

The ADSP-21371/ADSP-21375 processors have a total of three timers: a core timer that can generate periodic software interrupts and two general purpose timers that can generate periodic interrupts and be independently set to operate in one of three modes:

- · Pulse waveform generation mode
- Pulse width count/capture mode
- External event watchdog mode

The core timer can be configured to use FLAG3 as a timer expired signal, and each general-purpose timer has one bidirectional pin and four registers that implement its mode of operation: a 6-bit configuration register, a 32-bit count register, a 32-bit period register, and a 32-bit pulse width register. A single control and status register enables or disables both general-purpose timers independently.

#### 2-Wire Interface (TWI) Port

The TWI is a bidirectional 2-wire serial bus used to move 8-bit data while maintaining compliance with the I<sup>2</sup>C bus protocol. The TWI master incorporates the following features:

- · 7-bit addressing
- Simultaneous master and slave operation on multiple device systems with support for multi master data arbitration
- · Digital filtering and timed event processing
- 100 kbps and 400 kbps data rates
- · Low interrupt rate

#### **Pulse-Width Modulation**

The PWM module is a flexible, programmable, PWM waveform generator that can be programmed to generate the required switching patterns for various applications related to motor and engine control or audio power control. The PWM generator can generate either center-aligned or edge-aligned PWM waveforms. In addition, it can generate complementary signals on two outputs in paired mode or independent signals in non-paired mode (applicable to a single group of four PWM waveforms).

The entire PWM module has four groups of four PWM outputs each. Therefore, this module generates 16 PWM outputs in total. Each PWM group produces two pairs of PWM signals on the four PWM outputs.

The PWM generator is capable of operating in two distinct modes while generating center-aligned PWM waveforms: single update mode or double update mode. In single update mode the duty cycle values are programmable only once per PWM period. This results in PWM patterns that are symmetrical about the mid-point of the PWM period. In double update mode, a second updating of the PWM registers is implemented at the mid-point of the PWM period. In this mode, it is possible to produce asymmetrical PWM patterns that produce lower harmonic distortion in three-phase PWM inverters.

### **ROM Based Security**

The ADSP-21371/ADSP-21375 processors have a ROM security feature that provides hardware support for securing user software code by preventing unauthorized reading from the internal code when enabled. When using this feature, the processor does not boot-load any external code, executing exclusively from internal SRAM/ROM. Additionally, the processor is not freely accessible via the JTAG port. Instead, a unique 64-bit key, which must be scanned in through the JTAG or Test Access Port will be assigned to each customer. The device will ignore a wrong key. Emulation features and external boot modes are only available after the correct key is scanned.

### **SYSTEM DESIGN**

The following sections provide an introduction to system design options and power supply issues.

### **Program Booting**

The internal memory of the ADSP-21371/ADSP-21375 boots at system power-up from an 8-bit EPROM via the external port, an SPI master, or an SPI slave. Booting is determined by the boot configuration (BOOTCFG1–0) pins (see Table 9 on Page 15). Selection of the boot source is controlled via the SPI as either a master or slave device, or it can immediately begin executing from ROM.

The newly introduced "Running Reset" feature allows a user to perform a reset of the processor core and peripherals, but without resetting the PLL and SDRAM controller, or performing a Boot. The functionality of the CLKOUT/RESETOUT/RUNRSTIN pin has now been extended to also act as the input for initiating a Running Reset.

### **Power Supplies**

The ADSP-21371/ADSP-21375 processors have separate power supply connections for the internal ( $V_{\text{DDINT}}$ ), and external ( $V_{\text{DDEXT}}$ ) power supplies. The internal supplies must meet the 1.2 V requirement. The external supply must meet the 3.3 V requirement. All external supply pins must be connected to the same power supply.

### **Target Board JTAG Emulator Connector**

Analog Devices DSP Tools product line of JTAG emulators uses the IEEE 1149.1 JTAG test access port of the ADSP-21371/ ADSP-21375 processors to monitor and control the target board processor during emulation. Analog Devices DSP Tools product line of JTAG emulators provides emulation at full processor speed, allowing inspection and modification of memory, registers, and processor stacks. The processor's JTAG interface ensures that the emulator will not affect target system loading or timing.

For complete information on Analog Devices' SHARC DSP Tools product line of JTAG emulator operation, see the appropriate "Emulator Hardware User's Guide".

### **DEVELOPMENT TOOLS**

The ADSP-21371/ADSP-21375 processors are supported with a complete set of CROSSCORE software and hardware development tools, including Analog Devices emulators and VisualDSP++ development environment. The same emulator hardware that supports other SHARC processors also fully emulates the ADSP-21371/ADSP-21375.

The VisualDSP++ project management environment lets programmers develop and debug an application. This environment includes an easy to use assembler (which is based on an algebraic syntax), an archiver (librarian/library builder), a linker, a loader, a cycle-accurate instruction-level simulator, a C/C++ compiler, and a C/C++ runtime library that includes DSP and mathematical functions. A key point for these tools is C/C++ code efficiency. The compiler has been developed for efficient

translation of C/C++ code to DSP assembly. The SHARC has architectural features that improve the efficiency of compiled C/C++ code.

The VisualDSP++ debugger has a number of important features. Data visualization is enhanced by a plotting package that offers a significant level of flexibility. This graphical representation of user data enables the programmer to quickly determine the performance of an algorithm. As algorithms grow in complexity, this capability can have increasing significance on the designer's development schedule, increasing productivity. Statistical profiling enables the programmer to nonintrusively poll the processor as it is running the program. This feature, unique to VisualDSP++, enables the software developer to passively gather important code execution metrics without interrupting the real-time characteristics of the program. Essentially, the developer can identify bottlenecks in software quickly and efficiently. By using the profiler, the programmer can focus on those areas in the program that impact performance and take corrective action.

Debugging both C/C++ and assembly programs with the VisualDSP++ debugger, programmers can

- View mixed C/C++ and assembly code (interleaved source and object information)
- Insert breakpoints
- Set conditional breakpoints on registers, memory, and stacks
- Perform linear or statistical profiling of program execution
- Fill, dump, and graphically plot the contents of memory
- · Perform source level debugging
- Create custom debugger windows

The VisualDSP++ IDDE lets programmers define and manage DSP software development. Its dialog boxes and property pages let programmers configure and manage all of the SHARC development tools, including the color syntax highlighting in the VisualDSP++ editor. This capability permits programmers to

- Control how the development tools process inputs and generate outputs
- Maintain a one-to-one correspondence with the tool's command line switches

The VisualDSP++ Kernel (VDK) incorporates scheduling and resource management tailored specifically to address the memory and timing constraints of DSP programming. These capabilities enable engineers to develop code more effectively, eliminating the need to start from the very beginning, when developing new application code. The VDK features include threads, critical and unscheduled regions, semaphores, events, and device flags. The VDK also supports priority-based, preemptive, cooperative, and time-sliced scheduling approaches. In addition, the VDK was designed to be scalable. If the application does not use a specific feature, the support code for that feature is excluded from the target system.

Because the VDK is a library, a developer can decide whether to use it or not. The VDK is integrated into the VisualDSP++ development environment, but can also be used via standard command line tools. When the VDK is used, the development environment assists the developer with many error-prone tasks and assists in managing system resources, automating the generation of various VDK based objects, and visualizing the system state, when debugging an application that uses the VDK.

VisualDSP++ Component Software Engineering (VCSE) is Analog Devices' technology for creating, using, and reusing software components (independent modules of substantial functionality) to quickly and reliably assemble software applications. Download components from the Web and drop them into the application. Publish component archives from within VisualDSP++. VCSE supports component implementation in C/C++ or assembly language.

Use the Expert Linker to visually manipulate the placement of code and data on the embedded system. View memory utilization in a color-coded graphical form, easily move code and data to different areas of the processor or external memory with the drag of the mouse, examine run time stack and heap usage. The Expert Linker is fully compatible with the existing Linker Definition File (LDF), allowing the developer to move between the graphical and textual environments.

In addition to the software and hardware development tools available from Analog Devices, third parties provide a wide range of tools supporting the SHARC processor family. Hardware tools include SHARC processor PC plug-in cards. Third party software tools include DSP libraries, real-time operating systems, and block diagram design tools.

### Designing an Emulator-Compatible DSP Board (Target)

The Analog Devices family of emulators are tools that every DSP developer needs to test and debug hardware and software systems. Analog Devices has supplied an IEEE 1149.1 JTAG Test Access Port (TAP) on each JTAG DSP. Nonintrusive incircuit emulation is assured by the use of the processor's JTAG interface—the emulator does not affect target system loading or timing. The emulator uses the TAP to access the internal features of the processor, allowing the developer to load code, set breakpoints, observe variables, observe memory, and examine registers. The processor must be halted to send data and commands, but once an operation has been completed by the emulator, the DSP system is set running at full speed with no impact on system timing.

To use these emulators, the target board must include a header that connects the DSP's JTAG port to the emulator.

For details on target board design issues including mechanical layout, single processor connections, signal buffering, signal termination, and emulator pod logic, see the *EE-68: Analog Devices JTAG Emulation Technical Reference* on the Analog Devices website (www.analog.com)—use site search on "EE-68." This document is updated regularly to keep pace with improvements to emulator support.

#### **Evaluation Kit**

Analog Devices offers a range of EZ-KIT Lite<sup>®</sup> evaluation platforms to use as a cost effective method to learn more about developing or prototyping applications with Analog Devices processors, platforms, and software tools. Each EZ-KIT Lite includes an evaluation board along with an evaluation suite of the VisualDSP++<sup>®</sup> development and debugging environment with the C/C++ compiler, assembler, and linker. Also included are sample application programs, power supply, and a USB cable. All evaluation versions of the software tools are limited for use only with the EZ-KIT Lite product.

The USB controller on the EZ-KIT Lite board connects the board to the USB port of the user's PC, enabling the VisualDSP++ evaluation suite to emulate the on-board processor in-circuit. This permits the customer to download, execute, and debug programs for the EZ-KIT Lite system. It also allows in-circuit programming of the on-board Flash device to store user-specific boot code, enabling the board to run as a standal-one unit without being connected to the PC.

With a full version of VisualDSP++ installed (sold separately), engineers can develop software for the EZ-KIT Lite or any custom defined system. Connecting one of Analog Devices JTAG emulators to the EZ-KIT Lite board enables high speed, non-intrusive emulation.

### **ADDITIONAL INFORMATION**

This data sheet provides a general overview of the ADSP-21371/ ADSP-21375 architecture and functionality. For detailed information on the ADSP-21371/ADSP-21375 family core architecture and instruction set, refer to the *ADSP-2136x SHARC Processor Programming Reference*.

## PIN FUNCTION DESCRIPTIONS

The following symbols appear in the Type column of Table 6: A = asynchronous, I = input, O = output, S = synchronous, (A/D) = active drive, (O/D) = open drain, and T = three-state, (pd) = pull-down resistor, (pu) = pull-up resistor.

Table 6. Pin List

| Name                   | Туре                                     | State During and After Reset | Description   |
|------------------------|--|------------------------------|---|
| ADDR <sub>23-0</sub>   | O/T (pu)                                 | Pulled high/                 | <b>External Address.</b> The ADSP-21371/ADSP-21375 outputs addresses for external memory  |
|                        | ·  | driven low                   | and peripherals on these pins.  |
| DATA <sub>31-0</sub>   | I/O (pu)                                 | Pulled high/<br>pulled high  | <b>External Data.</b> The data pins can be multiplexed to support the external memory interface data (I/O), the PDAP (I) (PDAP for ADSP-21371), FLAGS (I/O) and PWM (O). After reset, all DATA pins are in EMIF mode and FLAG(0-3) pins will be in FLAGS mode (default). When configured in the IDP_PDAP_CTL register, IDP channel 0 scans the DATA <sub>31-8</sub> pins for parallel input data.   |
| DAI_P <sub>20-1</sub>  | I/O with<br>programmable pu <sup>1</sup> | Pulled high/<br>pulled high  | Digital Applications Interface Pins. These pins provide the physical interface to the DAI SRU. The DAI SRU configuration registers define the combination of on-chip audiocentric peripheral inputs or outputs connected to the pin and to the pin's output enable. The configuration registers of these peripherals then determines the exact behavior of the pin. Any input or output signal present in the DAI SRU may be routed to any of these pins. The DAI SRU provides the connection from the serial ports, the S/PDIF module (S/PDIF for ADSP-21371), input data ports (2), and the precision clock generators (4), to the DAI_P20-1 pins. Pullups can be disabled via the DAI_PIN_PULLUP register. |
| DPI _P <sub>14-1</sub> | I/O with programmable pu <sup>1</sup>    | Pulled high/<br>pulled high  | <b>Digital Peripheral Interface.</b> These pins provide the physical interface to the DPI SRU. The DPI SRU configuration registers define the combination of on-chip peripheral inputs or outputs connected to the pin and to the pin's output enable. The configuration registers of these peripherals then determines the exact behavior of the pin. Any input or output signal present in the DPI SRU may be routed to any of these pins. The DPI SRU provides the connection from the timers (2), SPIs (2), UART (1), flags (12), and general-purpose I/O (9) to the DPI_P14-1 pins. Pull-ups can be disabled via the DPI_PIN_PULLUP register.  |
| ACK                    | I (pu)                                   |                              | <b>Memory Acknowledge.</b> External devices can deassert ACK (low) to add wait states to an external memory access. ACK is used by I/O devices, memory controllers, or other periph-  |
|                        | 0.77()                                   | 5 11 11 1 1                  | erals to hold off completion of an external memory access.  |
| RD                     | O/T (pu)                                 | Pulled high/<br>driven high  | <b>External Port Read Enable.</b> $\overline{RD}$ is asserted whenever the ADSP-21371/ADSP-21375 reads a word from external memory. $\overline{RD}$ has a 22.5 k $\Omega$ internal pull-up resistor.  |
| WR                     | O/T (pu)                                 | Pulled high/<br>driven high  | <b>External Port Write Enable.</b> WR is asserted when the ADSP-21371/ADSP-21375 writes a word to external memory. WR has a 22.5 k $\Omega$ internal pull-up resistor.  |
| SDRAS                  | O/T (pu)                                 | Pulled high/<br>driven high  | <b>SDRAM Row Address Strobe.</b> Connect to SDRAM's RAS pin. In conjunction with other SDRAM command pins, defines the operation for the SDRAM to perform.  |
| SDCAS                  | O/T (pu)                                 | Pulled high/<br>driven high  | <b>SDRAM Column Address Select.</b> Connect to SDRAM's CAS pin. In conjunction with other SDRAM command pins, defines the operation for the SDRAM to perform.   |
| SDWE                   | O/T (pu)                                 | Pulled high/<br>driven high  | SDRAM Write Enable. Connect to SDRAM's WE or W buffer pin.  |
| SDCKE                  | O/T (pu)                                 | Pulled high/<br>driven high  | <b>SDRAM Clock Enable.</b> Connect to SDRAM's CKE pin. Enables and disables the CLK signal. For details, see the data sheet supplied with the SDRAM device.   |
| SDA10                  | O/T (pu)                                 | Pulled high/<br>driven low   | <b>SDRAM A10 Pin.</b> Enables applications to refresh an SDRAM in parallel with a non-SDRAM accesses. This pin replaces the DSP's A10 pin only during SDRAM accesses.   |
| SDCLK                  | O/T                                      | High-Z/driving               | SDRAM Clock.  |
| MS <sub>0-1</sub>      | O/T (pu)                                 | Pulled high/<br>driven high  | <b>Memory Select Lines 0–1.</b> These lines are asserted (low) as chip selects for the corresponding banks of external memory. The $\overline{\text{MS}}_{3-0}$ lines are decoded memory address lines that change at the same time as the other address lines. When no external memory access is occurring the $\overline{\text{MS}}_{3-0}$ lines are inactive; they are active however when a conditional memory access instruction is executed, whether or not the condition is true. The $\overline{\text{MS}}_{1}$ pin can be used in EPORT/FLASH boot mode. For more information, see the ADSP-2136X SHARC Processor Hardware Reference for the ADSP-21367/8/9 Processors.                              |

Table 6. Pin List (Continued)

| Name                             | Туре                             | State During and After Reset | Description  |
|----------------------------------|----------------------------------|------------------------------|--|
| FLAG[0]/IRQ0                     | I/O                              | High-Z/high-Z                | FLAGO/Interrupt Request0.  |
| FLAG[1]/IRQ1                     | I/O                              | High-Z/high-Z                | FLAG1/Interrupt Request1.  |
| FLAG[2]/IRQ2/                    | I/O with                         | High-Z/high-Z                | FLAG2/Interrupt Request/Memory Select2.  |
| MS2                              | programmable pu<br>(for MS mode) |                              |  |
| FLAG[3]/TIMEXP/                  | I/O with                         | High-Z/high-Z                | FLAG3/Timer Expired/Memory Select3.  |
| MS3                              | programmable pu<br>(for MS mode) |                              |  |
| TDI                              | I (pu)                           |                              | <b>Test Data Input (JTAG).</b> Provides serial data for the boundary scan logic. TDI has a 22.5 k $\Omega$ internal pull-up resistor.  |
| TDO                              | O /T                             |                              | Test Data Output (JTAG). Serial scan output of the boundary scan path.   |
| TMS                              | I (pu)                           |                              | <b>Test Mode Select (JTAG).</b> Used to control the test state machine. TMS has a 22.5 k $\Omega$ internal pull-up resistor.   |
| TCK                              | I                                |                              | <b>Test Clock (JTAG).</b> Provides a clock for JTAG boundary scan. TCK must be asserted (pulsed low) after power-up or held low for proper operation of the ADSP-21371/ADSP-21375.   |
| TRST                             | I (pu)                           |                              | <b>Test Reset (JTAG).</b> Resets the test state machine. $\overline{TRST}$ must be asserted (pulsed low) after power-up or held low for proper operation of the ADSP-21371/ADSP-21375. $\overline{TRST}$ has a 22.5 k $\Omega$ internal pull-up resistor.  |
| EMU                              | O/T (pu)                         |                              | <b>Emulation Status.</b> Must be connected to the ADSP-21371/ADSP-21375 Analog Devices DSP Tools product line of JTAG emulators target board connector only. $\overline{\text{EMU}}$ has a 22.5 k $\Omega$ internal pull-up resistor.  |
| CLK_CFG <sub>1-0</sub>           | I                                |                              | <b>Core to CLKIN Ratio Control.</b> These pins set the start up clock frequency. See Table 10 for a description of the clock configuration modes.  |
|                                  |                                  |                              | Note that the operating frequency can be changed by programming the PLL multiplier and divider in the PMCTL register at any time after the core comes out of reset.  |
| BOOT_CFG <sub>1-0</sub>          | I                                |                              | <b>Boot Configuration Select.</b> These pins select the boot mode for the processor. The BOOTCFG pins must be valid before reset is asserted. See Table 9 for a description of the boot modes.   |
| RESET                            | I                                |                              | <b>Processor Reset.</b> Resets the ADSP-21371/ADSP-21375 to a known state. Upon deassertion, there is a 4096 CLKIN cycle latency for the PLL to lock. After this time, the core begins program execution from the hardware reset vector address. The RESET input must be asserted (low) at power-up.   |
| XTAL                             | 0                                |                              | <b>Crystal Oscillator Terminal.</b> Used in conjunction with CLKIN to drive an external crystal.   |
| CLKIN                            |                                  |                              | <b>Local Clock In.</b> Used in conjunction with XTAL. CLKIN is the ADSP-21371/ADSP-21375 clock input. It configures the ADSP-21371/ADSP-21375 to use either its internal clock generator or an external clock source. Connecting the necessary components to CLKIN and XTAL enables the internal clock generator. Connecting the external clock to CLKIN while leaving XTAL unconnected configures the ADSP-21371/ADSP-21375 to use the external clock source such as an external clock oscillator. CLKIN may not be halted, changed, or operated below the specified frequency. |
| CLKOUT/<br>RESETOUT/<br>RUNRSTIN | I/O (pu)                         |                              | Clock Out/Reset Out/Running Reset In. The functionality can be switched between the PLL output clock and reset out by setting Bit 12 of the PMCTL register. The default is reset out. This pin also has a third function as RUNRSTIN. The functionality of which is enabled by setting Bit 0 of the RUNRSTCTL register. For more information, see the ADSP-2136X SHARC Processor Hardware Reference for the ADSP-21367/8/9 Processors.   |

 $<sup>^{\</sup>rm 1}$  Pull-up can be enabled/disabled, value of pull-up cannot be programmed.

### **DATA MODES, ADSP-21371**

For the ADSP-21371, the 32 data pins of the external memory interface are muxed (using bits in the SYSCTL register) to support the external memory interface data (input/output), the PDAP (input only), and the FLAGS (input/output). Table 7 provides the pin settings.

Table 7. ADSP-21371, Function of Data Pins

| DATA PIN MODE | DATA31-16                            | DATA15-8   | DATA7-0    |
|---------------|--------------------------------------|------------|------------|
| 000           |                                      | EPDATA32-0 |            |
| 001           | FLAGS/PWM15-0 <sup>1</sup>           |            | EPDATA15-0 |
| 010           | FLAGS/PWM15-0 <sup>1</sup> FLAGS15-8 |            | EPDATA7-0  |
| 011           | FLAGS/PWM15-0 <sup>1</sup> FLAGS15-0 |            | FLAGS15-0  |
| 100           | PDAP (DATA + CTRL) EPDATA7-0         |            | EPDATA7-0  |
| 101           | PDAP (DATA + CTRL) FLAGS7–0          |            | FLAGS7-0   |
| 110           | Reserved                             |            |            |
| 111           | Three-state all pins                 |            |            |

<sup>&</sup>lt;sup>1</sup>These signals can be FLAGS or PWM or a mix of both. However, they can be selected only in groups of four. Their function is determined by the control signals FLAGS/PWM\_SEL. For more information, see the ADSP-2136x SHARC Processor Hardware Reference for the ADSP-21367/8/9 Processors.

### **DATA MODES, ADSP-21375**

For the ADSP-21375, the 16 data pins of the external memory interface are muxed (using bits in the SYSCTL register) to support the external memory interface data (input/output), the PDAP (input only) (PDAP for ADSP-21371), and the FLAGS (input/output). Table 8 provides the pin settings.

Table 8. ADSP-21375, Function of Data Pins

| DATA PIN MODE | DATA15-0  | DATA7-0       |
|---------------|-----------|---------------|
| 000           | EPD/      | ATA15-0       |
| 001           | EPDA      | ATA15-0       |
| 010           | FLAGS15-8 | EPDATA7-0     |
| 011           | FLA       | G15-0         |
| 100           |           | EPDATA7-0     |
| 101           |           | FLAGS7-0      |
| 110           | Res       | served        |
| 111           | Three-si  | tate all pins |

### **BOOT MODES**

**Table 9. Boot Mode Selection** 

| BOOTCFG1-0 | Booting Mode     |
|------------|------------------|
| 00         | SPI Slave Boot   |
| 01         | SPI Master Boot  |
| 10         | EPROM/FLASH Boot |
| 11         | Reserved         |

### **CORE INSTRUCTION RATE TO CLKIN RATIO MODES**

For details on processor timing, see Timing Specifications and Figure 3 on Page 18.

Table 10. Core Instruction Rate/CLKIN Ratio Selection

| CLKCFG1-0 | Core to CLKIN Ratio |
|-----------|---------------------|
| 00        | 6:1                 |
| 01        | 32:1                |
| 10        | 16:1                |
| 11        | Reserved            |

### ADSP-21371/ADSP-21375 SPECIFICATIONS

### **OPERATING CONDITIONS**

| Parameter <sup>1</sup>     | Description   | Min  | Max               | Unit |
|----------------------------|---|------|-------------------|------|
| V <sub>DDINT</sub>         | Internal (Core) Supply Voltage  | 1.14 | 1.26              | V    |
| $V_{\text{DDEXT}}$         | External (I/O) Supply Voltage   | 3.13 | 3.47              | V    |
| $V_{IH}^{2}$               | High Level Input Voltage @ V <sub>DDEXT</sub> = max                       | 2.0  | $V_{DDEXT} + 0.5$ | V    |
| $V_{IL}^2$                 | Low Level Input Voltage @ V <sub>DDEXT</sub> = min                        | -0.5 | +0.8              | V    |
| $V_{\text{IH\_CLKIN}}^{3}$ | High Level Input Voltage @ V <sub>DDEXT</sub> = max                       | 1.74 | $V_{DDEXT} + 0.5$ | V    |
| $V_{IL\_CLKIN}^3$          | Low Level Input Voltage @ V <sub>DDEXT</sub> = min                        | -0.5 | +1.10             | V    |
| T <sub>JUNCTION</sub>      | Junction Temperature 208-Lead MQFP-EP @ T <sub>AMBIENT</sub> 0°C to +70°C | 0    | 115               | °C   |

 $<sup>^{\</sup>rm 1}{\rm Specifications}$  subject to change without notice.

### **ELECTRICAL CHARACTERISTICS**

| Parameter <sup>1</sup>           | Description                         | Test Conditions   | Min | Тур | Max | Unit |
|----------------------------------|-------------------------------------|---|-----|-----|-----|------|
| V <sub>OH</sub> <sup>2</sup>     | High Level Output Voltage           | @ $V_{DDEXT} = min$ , $I_{OH} = -1.0 \text{ mA}^3$                              | 2.4 |     |     | ٧    |
| $V_{\text{OL}}^{2}$              | Low Level Output Voltage            | @ $V_{DDEXT} = min, I_{OL} = 1.0 \text{ mA}^3$                                  |     |     | 0.4 | V    |
| I <sub>IH</sub> <sup>4, 5</sup>  | High Level Input Current            | $@V_{DDEXT} = max, V_{IN} = V_{DDEXT} max$                                      |     |     | 10  | μΑ   |
| $I_{\rm IL}^{}$                  | Low Level Input Current             | $@V_{DDEXT} = max, V_{IN} = 0 V$  |     |     | 10  | μΑ   |
| I <sub>ILPU</sub> <sup>5</sup>   | Low Level Input Current Pull-up     | $@V_{DDEXT} = max, V_{IN} = 0 V$  |     |     | 200 | μΑ   |
| I <sub>OZH</sub> <sup>6, 7</sup> | Three-State Leakage Current         | $@V_{DDEXT} = max, V_{IN} = V_{DDEXT} max$                                      |     |     | 10  | μΑ   |
| I <sub>OZL</sub> <sup>6</sup>    | Three-State Leakage Current         | $@V_{DDEXT} = max, V_{IN} = 0 V$  |     |     | 10  | μΑ   |
| I <sub>OZLPU</sub> <sup>7</sup>  | Three-State Leakage Current Pull-up | $@V_{DDEXT} = max, V_{IN} = 0 V$  |     |     | 200 | μΑ   |
| I <sub>DD-INTYP</sub> 8, 9       | Supply Current (Internal)           | $t_{CCLK} = 3.75 \text{ ns, } V_{DDINT} = 1.2 \text{ V, } 25^{\circ}\text{C}$   |     | 600 |     | mA   |
| C <sub>IN</sub> 10, 11           | Input Capacitance                   | $f_{IN} = 1 \text{ MHz}, T_{CASE} = 25^{\circ}\text{C}, V_{IN} = 1.2 \text{ V}$ |     |     | 4.7 | pF   |

<sup>&</sup>lt;sup>1</sup> Specifications subject to change without notice.

<sup>&</sup>lt;sup>2</sup> Applies to input and bidirectional pins: AD23–0, DATA31–0, FLAG3–0, DAI\_Px, DPI\_Px, \$\overline{\text{SPIDS}}\$, BOOTCFGx, CLKCFGx, CLKOUT (\$\overline{\text{RUNRSTIN}}\$), \$\overline{\text{RESET}}\$, TCK, TMS, TDI, \$\overline{\text{TRST}}\$.

<sup>&</sup>lt;sup>3</sup> Applies to input pin CLKIN.

<sup>&</sup>lt;sup>2</sup> Applies to output and bidirectional pins: ADDR23-0, DATA31-0, \overline{RD}, \overline{WR}, FLAG3-0, DAI\_Px, DPI\_Px, \overline{EMU}, TDO, CLKOUT, \overline{SDRAS}, \overline{SDCAS}, \overline{SDWE}, SDCKE, SDA10, and SDCLK0.

 $<sup>^3</sup>$  See Output Drive Currents on Page 45 for typical drive current capabilities.

<sup>&</sup>lt;sup>4</sup>Applies to input pins: BOOTCFGx, CLKCFGx, TCK, RESET, CLKIN.

 $<sup>^5</sup>$  Applies to input pins with 22.5 k $\Omega$  internal pull-ups:  $\overline{TRST},$  TMS, TDI.

<sup>&</sup>lt;sup>6</sup>Applies to three-statable pins: FLAG3-0.

<sup>&</sup>lt;sup>7</sup> Applies to three-statable pins with 22.5 kΩ pull-ups: DAI\_Px, DPI\_Px,  $\overline{EMU}$ .

<sup>&</sup>lt;sup>8</sup>Typical internal current data reflects nominal operating conditions.

<sup>&</sup>lt;sup>9</sup> See Engineer-to-Engineer Note "Estimating Power Dissipation for ADSP-2137x SHARC Processors" (EE-318) for further information.

<sup>&</sup>lt;sup>10</sup>Applies to all signal pins.

<sup>&</sup>lt;sup>11</sup>Guaranteed, but not tested.

#### PACKAGE INFORMATION

The information presented in Figure 2 provides details about the package branding for the ADSP-21371/ADSP-21375 processor. For a complete listing of product availability, see Ordering Guide on Page 51.



Figure 2. Typical Package Brand

Table 11. Package Brand Information

| Brand Key | Field Description   |
|-----------|---------------------|
| t         | Temperature Range   |
| рр        | Package Type        |
| Z         | RoHS Compliant Part |
| ссс       | See Ordering Guide  |
| vvvvv.x   | Assembly Lot Code   |
| n.n       | Silicon Revision    |
| yyww      | Date Code           |

### **ESD SENSITIVITY**



### ESD (electrostatic discharge) sensitive device.

Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be take to avoid performance degradation or loss of functionality.

#### **MAXIMUM POWER DISSIPATION**

See Engineer-to-Engineer Note "Estimating Power Dissipation for ADSP-2137x SHARC Processors" (EE-318) for detailed thermal and power information regarding maximum power dissipation. For information on package thermal specifications, see Thermal Characteristics on Page 46.

### **ABSOLUTE MAXIMUM RATINGS**

Stresses greater than those listed in Table 12 may cause permanent damage to the device. These are stress ratings only; functional operation of the device at these or any other conditions greater than those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Table 12. Absolute Maximum Ratings

| Parameter   | Rating           |
|---|------------------|
| Internal (Core) Supply Voltage (V <sub>DDINT</sub> )        | -0.3 V to +1.5 V |
| External (I/O) Supply Voltage (V <sub>DDEXT</sub> )         | -0.3 V to +4.6 V |
| Input Voltage –0.5 V to V <sub>DDEXT</sub>                  | +0.5 V           |
| Output Voltage Swing $-0.5 \text{ V}$ to $V_{\text{DDEXT}}$ | +0.5 V           |
| Load Capacitance  | 200 pF           |
| Storage Temperature Range                                   | −65°C to +150°C  |
| Junction Temperature under Bias                             | 125°C            |

### TIMING SPECIFICATIONS

The ADSP-21371/ADSP-21375's internal clock (a multiple of CLKIN) provides the clock signal for timing internal memory, processor core, and serial ports. During reset, program the ratio between the processor's internal clock frequency and external (CLKIN) clock frequency with the CLKCFG1–0 pins (see Table 10 on Page 15). To determine switching frequencies for

the serial ports, divide down the internal clock, using the programmable divider control of each port (DIVx for the serial ports).

Figure 3 shows core to CLKIN ratios of 6:1, 16:1, and 32:1 with external oscillator or crystal. Note that more ratios are possible and can be set through software using the power management control register (PMCTL). For more information, see the *ADSP-2136x SHARC Processor Programming Reference*.

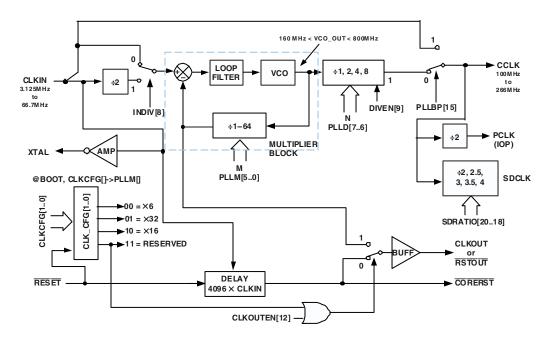


Figure 3. Core Clock and System Clock Relationship to CLKIN

The ADSP-21371/ADSP-21375's internal clock switches at higher frequencies than the system input clock (CLKIN). To generate the internal clock, the processor uses an internal phase-locked loop (PLL). This PLL-based clocking minimizes the skew between the system clock (CLKIN) signal and the processor's internal clock.

Core clock frequency can be calculated as:

$$CCLK = 1 / t_{CCLK} = f_{INPUT} \times (PLLM/PLLD)$$

Note that in the user application, the PLL multiplier value should be selected in such a way that the VCO frequency falls in between 160 MHz and 800 MHz. The VCO frequency is calculated as follows:

where:

 $f_{VCO} = 2 \times PLLM \times f_{INPUT}$ .

*PLLM* = multiplier value programmed.

*PLLD* = divider value programmed.

 $f_{INPUT}$  = input frequency to the PLL.

 $f_{INPUT}$  = CLKIN when the input divider is disabled.

 $f_{INPUT}$  = CLKIN/2 when the input divider is enabled.

Note the definitions of various clock periods shown in Table 14 which are a function of CLKIN and the appropriate ratio control shown in Table 13.

Table 13. ADSP-21371/ADSP-21375 CLKIN and CCLK Clock Generation Operation

| Timing<br>Requirements | Description | Calculation         |
|------------------------|-------------|---------------------|
| CLKIN                  | Input Clock | 1/t <sub>CK</sub>   |
| CCLK                   | Core Clock  | 1/t <sub>CCLK</sub> |

Table 14. Clock Periods

| Timing              |   |
|---------------------|---|
| Requirements        | Description <sup>1</sup>                          |
| t <sub>CK</sub>     | CLKIN Clock Period                                |
| t <sub>CCLK</sub>   | (Processor) Core Clock Period                     |
| t <sub>PCLK</sub>   | (Peripheral) Clock Period = $2 \times t_{CCLK}$   |
| t <sub>SCLK</sub>   | Serial Port Clock Period = $(t_{PCLK}) \times SR$ |
| t <sub>SDCLK</sub>  | $SDRAM\ Clock\ Period = (t_{CCLK}) \times SDR$    |
| t <sub>SPICLK</sub> | SPI Clock Period = $(t_{PCLLK}) \times SPIR$      |

<sup>1</sup> where

 $SR = serial\ port-to-core\ clock\ ratio\ (wide\ range,\ determined\ by\ SPORT\ CLKDIV\ bits\ in\ DIVx\ register)$ 

SPIR = SPI-to-Core Clock Ratio (wide range, determined by SPIBAUD register setting)

SDR=SDRAM-to-Core Clock Ratio (Values determined by bits 20-18 of the PMCTL register)

Use the exact timing information given. Do not attempt to derive parameters from the addition or subtraction of others. While addition or subtraction would yield meaningful results for an individual device, the values given in this data sheet reflect statistical variations and worst cases. Consequently, it is not meaningful to add parameters to derive longer times. See Figure 36 on Page 45 under Test Conditions for voltage reference levels.

Switching Characteristics specify how the processor changes its signals. Circuitry external to the processor must be designed for compatibility with these signal characteristics. Switching characteristics describe what the processor will do in a given circumstance. Use switching characteristics to ensure that any timing requirement of a device connected to the processor (such as memory) is satisfied.

Timing Requirements apply to signals that are controlled by circuitry external to the processor, such as the data input for a read operation. Timing requirements guarantee that the processor operates correctly with other devices.

### **Power-Up Sequencing**

The timing requirements for processor startup are given in Table 15.

Table 15. Power Up Sequencing Timing Requirements (Processor Startup)

| Parameter             |  | Min                             |                        | Unit |
|-----------------------|--|---------------------------------|------------------------|------|
| Timing Require        | ments  |                                 |                        |      |
| $t_{RSTVDD}$          | RESET Low Before V <sub>DDINT</sub> /V <sub>DDEXT</sub> On     | 0                               |                        | ns   |
| t <sub>IVDDEVDD</sub> | $V_{DDINT}$ on Before $V_{DDEXT}$                              | -50                             | +200                   | ms   |
| t <sub>CLKVDD</sub> 1 | CLKIN Valid After V <sub>DDINT</sub> /V <sub>DDEXT</sub> Valid | 0                               | 200                    | ms   |
| t <sub>CLKRST</sub>   | CLKIN Valid Before RESET Deasserted                            | 10 <sup>2</sup>                 |                        | μs   |
| t <sub>PLLRST</sub>   | PLL Control Setup Before RESET Deasserted                      | 20 <sup>3</sup>                 |                        | μs   |
| Switching Char        | racteristic  |                                 |                        |      |
| t <sub>CORERST</sub>  | Core Reset Deasserted After RESET Deasserted                   | $4096 \times t_{CK} + 2 \times$ | t <sub>CCLK</sub> 4, 5 |      |

<sup>&</sup>lt;sup>1</sup> Valid V<sub>DDINT</sub>/V<sub>DDEXT</sub> assumes that the supplies are fully ramped to their 1.2 and 3.3 volt rails. Voltage ramp rates can vary from microseconds to hundreds of milliseconds depending on the design of the power supply subsystem.

<sup>&</sup>lt;sup>5</sup>The 4096 cycle count depends on t<sub>SRST</sub> specification in Table 17. If setup time is not met, one additional CLKIN cycle may be added to the core reset time, resulting in 4097 cycles maximum.

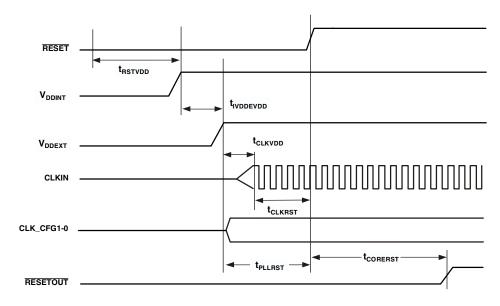


Figure 4. Power-Up Sequencing

<sup>&</sup>lt;sup>2</sup> Assumes a stable CLKIN signal, after meeting worst-case startup timing of crystal oscillators. Refer to your crystal oscillator manufacturer's datasheet for startup time. Assume a 25 ms maximum oscillator startup time if using the XTAL pin and internal oscillator circuit in conjunction with an external crystal.

<sup>&</sup>lt;sup>3</sup> Based on CLKIN cycles.

<sup>&</sup>lt;sup>4</sup> Applies after the power-up sequence is complete. Subsequent resets require a minimum of four CLKIN cycles for RESET to be held low in order to properly initialize and propagate default states at all I/O pins.

### **Clock Input**

Table 16. Clock Input

|                                |                                  |                    | 266 MHz |      |  |
|--------------------------------|----------------------------------|--------------------|---------|------|--|
| Parameter                      |                                  | Min                | Max     | Unit |  |
| Timing Requ                    | irements                         |                    |         |      |  |
| $t_{CK}$                       | CLKIN Period                     | 22.5 <sup>1</sup>  | 100     | ns   |  |
| $t_{CKL}$                      | CLKIN Width Low                  | 11.25 <sup>1</sup> | 45      | ns   |  |
| t <sub>CKH</sub>               | CLKIN Width High                 | 11.25 <sup>1</sup> | 45      | ns   |  |
| t <sub>CKRF</sub>              | CLKIN Rise/Fall (0.4 V to 2.0 V) |                    | 6       | ns   |  |
| t <sub>CCLK</sub> <sup>2</sup> | CCLK Period                      | 3.75 <sup>1</sup>  | 10      | ns   |  |

<sup>&</sup>lt;sup>1</sup> Applies only for CLKCFG1-0 = 00 and default values for PLL control bits in PMCTL.

<sup>&</sup>lt;sup>2</sup> Any changes to PLL control bits in the PMCTL register must meet core clock timing specification t<sub>CCLK</sub>.

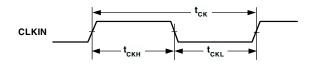
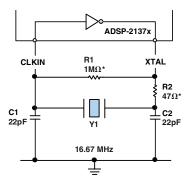


Figure 5. Clock Input

### **Clock Signals**

The ADSP-21371/ADSP-21375 can use an external clock or a crystal. See the CLKIN pin description in Table 6. The programmer can configure the ADSP-21371/ADSP-21375 to use its internal clock generator by connecting the necessary components to CLKIN and XTAL. Figure 6 shows the component connections used for a crystal operating in fundamental mode. Note that the clock rate is achieved using a 16.67 MHz crystal and a PLL multiplier ratio 16:1 (CCLK:CLKIN achieves a clock speed of 266 MHz). To achieve the full core clock rate, programs need to configure the multiplier bits in the PMCTL register.



R2 SHOULD BE CHOSEN TO LIMIT CRYSTAL DRIVE POWER. REFER TO CRYSTAL MANUFACTURER'S SPECIFICATIONS

\*TYPICAL VALUES

Figure 6. 266 MHz Operation (Fundamental Mode Crystal)

#### Reset

Table 17. Reset

| Paramete            | r                            | Min               | Max | Unit |
|---------------------|------------------------------|-------------------|-----|------|
| Timing Red          | quirements                   |                   |     |      |
| t <sub>WRST</sub> 1 | RESET Pulse Width Low        | $4 \times t_{CK}$ |     | ns   |
| t <sub>SRST</sub>   | RESET Setup Before CLKIN Low | 8                 |     | ns   |

 $<sup>^{1}</sup> Applies after the power-up sequence is complete. At power-up, the processor's internal phase-locked loop requires no more than 100 ms while \overline{RESET} is low, assuming stable V_{DD} and CLKIN (not including start-up time of external clock oscillator).$ 

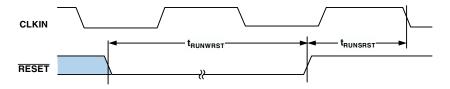


Figure 7. Reset

### **Running Reset**

The following timing specification applies to CLKOUT/  $\overline{RESETOUT/RUNRSTIN}$  pin when it is configured as  $\overline{RUNRSTIN}$ .

Table 18. Running Reset

| Parameter            |                                       | Min                      | Max | Unit |
|----------------------|---------------------------------------|--------------------------|-----|------|
| Timing Requ          | irements                              |                          |     |      |
| t <sub>WRUNRST</sub> | Running RESET Pulse Width Low         | $4 \times t_{\text{CK}}$ |     | ns   |
| t <sub>SRUNRST</sub> | Running RESET Setup Before CLKIN High | 8                        |     | ns   |

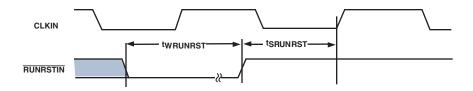


Figure 8. Running Reset

### Interrupts

The following timing specification applies to the FLAG0, FLAG1, and FLAG2 pins when they are configured as  $\overline{IRQ0}$ ,  $\overline{IRQ1}$ , and  $\overline{IRQ2}$  interrupts as well as the DAI\_P20-1 and DPI\_P14-1 pins when they are configured as interrupts.

#### Table 19. Interrupts

| Parameter        |                  | Min                     | Max | Unit |
|------------------|------------------|-------------------------|-----|------|
| Timing Requiren  | nent             |                         |     |      |
| t <sub>IPW</sub> | IRQx Pulse Width | $2 \times t_{PCLK} + 2$ |     | ns   |



Figure 9. Interrupts

### **Core Timer**

The following timing specification applies to FLAG3 when it is configured as the core timer (CTIMER).

Table 20. Core Timer

| Paramete           | r                  | Min                     | Max | Unit |
|--------------------|--------------------|-------------------------|-----|------|
| Switching (        | Characteristic     |                         |     |      |
| $t_{\text{WCTIM}}$ | CTIMER Pulse Width | $4 \times t_{PCLK} - 1$ |     | ns   |

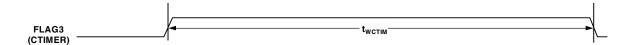


Figure 10. Core Timer

### Timer PWM\_OUT Cycle Timing

The following timing specification applies to Timer0 and Timer1 in PWM\_OUT (pulse-width modulation) mode. Timer signals are routed to the DPI\_P14-1 pins through the DPI SRU. Therefore, the timing specifications provided below are valid at the DPI\_P14-1 pins.

Table 21. Timer PWM\_OUT Timing

| Parameter         |                          | Min                     | Max                                | Unit |
|-------------------|--------------------------|-------------------------|------------------------------------|------|
| Switching Chara   | cteristic                |                         |                                    |      |
| t <sub>PWMO</sub> | Timer Pulse Width Output | $2 \times t_{PCLK} - 2$ | $2\times(2^{31}-1)\times t_{PCLK}$ | ns   |

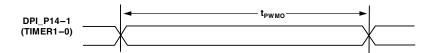


Figure 11. Timer PWM\_OUT Timing

### Timer WDTH\_CAP Timing

The following timing specification applies to timer0, timer1, and in WDTH\_CAP (pulse width count and capture) mode. Timer signals are routed to the DPI\_P14-1 pins through the SRU. Therefore, the timing specification provided below is valid at the DPI\_P14-1 pins.

Table 22. Timer Width Capture Timing

| Parameter          |                   | Min                 | Max                                | Unit |
|--------------------|-------------------|---------------------|------------------------------------|------|
| Timing Requirement |                   |                     |                                    |      |
| $t_{PWI}$          | Timer Pulse Width | $2 \times t_{PCLK}$ | $2\times(2^{31}-1)\times t_{PCLK}$ | ns   |

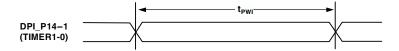


Figure 12. Timer Width Capture Timing

### Pin to Pin Direct Routing (DAI and DPI)

For direct pin connections only (for example, DAI\_PB01\_I to DAI\_PB02\_O).

Table 23. DAI Pin to Pin Routing

| Parameter         |   | Min | Max | Unit |
|-------------------|---|-----|-----|------|
| Timing Requirer   | ment  |     |     |      |
| t <sub>DPIO</sub> | Delay DAI/DPI Pin Input Valid to DAI Output Valid | 1.5 | 10  | ns   |

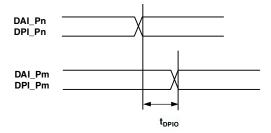


Figure 13. DAI Pin to Pin Direct Routing

### **Precision Clock Generator (Direct Pin Routing)**

This timing is only valid when the SRU is configured such that the precision clock generator (PCG) takes its inputs directly from the DAI pins (via pin buffers) and sends its outputs directly to the DAI pins. For the other cases, where the PCG's

inputs and outputs are not directly routed to/from DAI pins (via pin buffers) there is no timing data available. All timing parameters and switching characteristics apply to external DAI pins (DAI\_P01-DAI\_P20).

Table 24. Precision Clock Generator (Direct Pin Routing)

| Paramete              | er  | Min                                       | Max                                      | Unit |
|-----------------------|---|---|--|------|
| Timing Re             | quirements  |   |  |      |
| t <sub>PCGIW</sub>    | Input Clock Period  | 24  |  | ns   |
| t <sub>STRIG</sub>    | PCG Trigger Setup Before Falling Edge of PCG Input<br>Clock | 4.5                                       |  | ns   |
| t <sub>HTRIG</sub>    | PCG Trigger Hold After Falling Edge of PCG Input<br>Clock   | 3   |  | ns   |
| Switching             | Characteristics   |   |  |      |
| t <sub>DPCGIO</sub>   | PCG Output Clock and Frame Sync Active Edge Delay           |   |  |      |
|                       | After PCG Input Clock                                       | 2.5                                       | 10                                       | ns   |
| t <sub>DTRIGCLK</sub> | PCG Output Clock Delay After PCG Trigger                    | $2.5 + ((2.5) \times t_{PCGIW})$          | $10 + ((2.5) \times t_{PCGIW})$          | ns   |
| t <sub>DTRIGFS</sub>  | PCG Frame Sync Delay After PCG Trigger                      | $2.5 + ((2.5 + D - PH) \times t_{PCGIW})$ | $10 + ((2.5 + D - PH) \times t_{PCGIW})$ | ns   |
| $t_{PCGOW}^{1}$       | Output Clock Period   | $2 \times t_{PCGIW} - 1$                  |  | ns   |

D = FSxDIV, PH = FSxPHASE. For more information, see the ADSP-2136x SHARC Processor Hardware Reference for the ADSP-21368 Processor, "Precision Clock Generators" chapter.

<sup>&</sup>lt;sup>1</sup>Normal mode of operation.

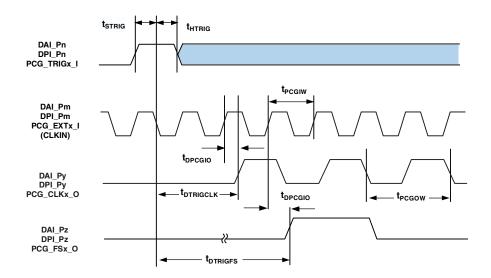


Figure 14. Precision Clock Generator (Direct Pin Routing)

### Flags

The timing specifications provided below apply to the FLAG3-0 and DPI\_P14-1 pins, and the DATA31-0 pins. See Table 6 on Page 13 for more information on flag use.

Table 25. Flags

| Parameter         |  | Min                     | Max | Unit |
|-------------------|--|-------------------------|-----|------|
| Timing Require    | ment   |                         |     |      |
| t <sub>FIPW</sub> | DPI_P14-1, DATA31-0, FLAG3-0 <sub>IN</sub> Pulse Width | $2 \times t_{PCLK} + 3$ |     | ns   |
| Switching Char    | racteristic  |                         |     |      |
| t <sub>FOPW</sub> | DPI_P14-1, DATA31-0, FLAG3-0 OUT Pulse Width           | $2 \times t_{PCLK} - 2$ |     | ns   |

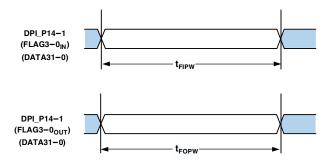


Figure 15. Flags

### SDRAM Interface Timing (133 MHz SDCLK)

Table 26. SDRAM Interface Timing<sup>1</sup>

| Parameter           |  | Min  | Max | Unit |
|---------------------|--|------|-----|------|
| Timing Requi        | irements   |      |     |      |
| t <sub>SSDAT</sub>  | DATA Setup Before SDCLK                            | 0.58 |     | ns   |
| t <sub>HSDAT</sub>  | DATA Hold After SDCLK                              | 2.2  |     | ns   |
| Switching Ch        | aracteristics                                      |      |     |      |
| t <sub>SDCLK</sub>  | SDCLK Period                                       | 7.5  |     | ns   |
| t <sub>SDCLKH</sub> | SDCLK Width High                                   | 3    |     | ns   |
| t <sub>SDCLKL</sub> | SDCLK Width Low                                    | 3    |     | ns   |
| t <sub>DCAD</sub>   | Command, ADDR, Data Delay After SDCLK <sup>2</sup> |      | 5.3 | ns   |
| $t_{HCAD}$          | Command, ADDR, Data Hold After SDCLK <sup>2</sup>  | 1.3  |     | ns   |
| t <sub>DSDAT</sub>  | Data Disable After SDCLK                           |      | 5.3 | ns   |
| t <sub>ENSDAT</sub> | Data Enable After SDCLK                            | 1.6  |     | ns   |

 $<sup>^{1}</sup>$  For F<sub>CCLK</sub> = 133 MHz (SDCLK ratio = 1:2).  $^{2}$  Command pins include: \$\overline{SDCAS}\$, \$\overline{SDRAS}\$, \$\overline{SDWE}\$, \$\overline{MSx}\$, \$SDA10, and \$SDCKE.}

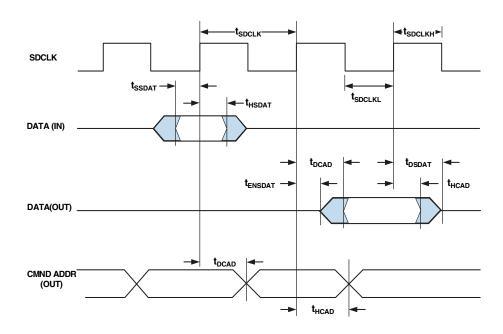


Figure 16. SDRAM Interface Timing for 133 MHz SDCLK

### Memory Read—Bus Master

Use these specifications for asynchronous interfacing to memories. Note that timing for ACK, DATA,  $\overline{\text{RD}}$ ,  $\overline{\text{WR}}$ , and strobe timing parameters only apply to asynchronous access mode.

Table 27. Memory Read—Bus Master

| Paramete          | r   | Min                           | Max                    | Unit |
|-------------------|---|-------------------------------|------------------------|------|
| Timing Req        | uirements   |                               |                        |      |
| $t_{DAD}$         | Address, Selects Delay to Data Valid 1, 2                       |                               | $W + t_{SDCLK} - 5.12$ | ns   |
| t <sub>DRLD</sub> | RD Low to Data Valid <sup>1</sup>                               |                               | W – 3                  | ns   |
| $t_{SDS}$         | Data Setup to RD High   | 2.2                           |                        | ns   |
| t <sub>HDRH</sub> | Data Hold from RD High <sup>3, 4</sup>                          | 0                             |                        | ns   |
| t <sub>DAAK</sub> | ACK Delay from Address, Selects <sup>2, 5</sup>                 |                               | $t_{SCDCLK} - 10. + W$ | ns   |
| t <sub>DSAK</sub> | ACK Delay from RD Low <sup>4</sup>                              |                               | W – 7.0                | ns   |
| Switching (       | Characteristics   |                               |                        |      |
| t <sub>DRHA</sub> | Address Selects Hold After RD High                              | RHC + 0.38                    |                        | ns   |
| t <sub>DARL</sub> | Address Selects to RD Low <sup>2</sup>                          | t <sub>SDCLK</sub> – 3.3      |                        | ns   |
| $t_{\text{RW}}$   | RD Pulse Width  | W – 1.4                       |                        | ns   |
| $t_{RWR}$         | $\overline{RD}$ High to $\overline{WR}$ , $\overline{RD}$ , Low | HI + t <sub>SDCLK</sub> - 0.8 |                        | ns   |

W =(number of wait states specified in AMICTLx register)  $\times t_{SDCLK}$ 

HI = RHC + IC (RHC = (number of Read Hold Cycles specified in AMICTLx register)  $\times$  t<sub>SDCLK</sub>

IC = (number of idle cycles specified in AMICTLx register)  $\times$  t<sub>SDCLK</sub>)

H =(number of hold cycles specified in AMICTLx register)  $\times$   $t_{SDCLK}$ 

 $<sup>^{5}</sup>$  ACK delay/setup: User must meet  $t_{DAAK}$ , or  $t_{DSAK}$ , for deassertion of ACK (low). For asynchronous assertion of ACK (high) user must meet  $t_{DAAK}$  or  $t_{DSAK}$ .

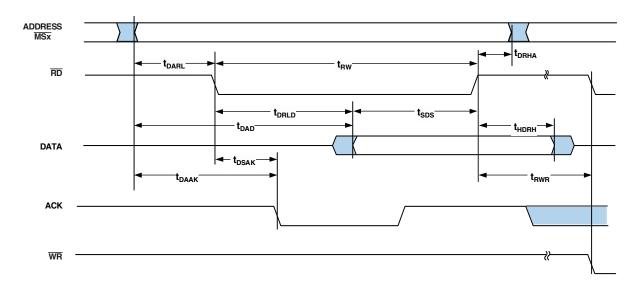


Figure 17. Memory Read—Bus Master

 $<sup>^{1}\,\</sup>mathrm{Data}$  delay/setup: System must meet  $t_{\mathrm{DAD}},$   $t_{\mathrm{DRLD}},$  or  $t_{SDS}.$ 

<sup>&</sup>lt;sup>2</sup> The falling edge of  $\frac{1}{MS}x$ , is referenced.

 $<sup>^3</sup>$ Note that timing for ACK, DATA,  $\overline{\text{RD}}$ ,  $\overline{\text{WR}}$ , and strobe timing parameters only apply to asynchronous access mode.

<sup>&</sup>lt;sup>4</sup>Data hold: User must meet t<sub>HDRH</sub> in asynchronous access mode. See Test Conditions on Page 45 for the calculation of hold times given capacitive and dc loads.

### Memory Write—Bus Master

Use these specifications for asynchronous interfacing to memories. Note that timing for ACK, DATA,  $\overline{\text{RD}}$ ,  $\overline{\text{WR}}$ , and strobe timing parameters only apply to asynchronous access mode.

Table 28. Memory Write—Bus Master

| Parameter           |   | Min                           | Max                    | Unit |
|---------------------|---|-------------------------------|------------------------|------|
| Timing Requ         | iirements   |                               |                        |      |
| t <sub>DAAK</sub>   | ACK Delay from Address, Selects <sup>1, 2</sup>             |                               | $t_{SDCLK} - 10.1 + W$ | ns   |
| t <sub>DSAK</sub>   | ACK Delay from $\overline{\mathrm{WR}}$ Low <sup>1, 3</sup> |                               | W – 7.1                | ns   |
| Switching Cl        | haracteristics  |                               |                        |      |
| t <sub>DAWH</sub>   | Address, Selects to WR Deasserted <sup>2</sup>              | $t_{SDCLK} - 3.6 + W$         |                        | ns   |
| t <sub>DAWL</sub>   | Address, Selects to $\overline{\rm WR}{\rm Low^2}$          | t <sub>SDCLK</sub> - 2.7      |                        | ns   |
| t <sub>ww</sub>     | WR Pulse Width  | W – 1.3                       |                        | ns   |
| t <sub>DDWH</sub>   | Data Setup Before WR High                                   | $t_{SDCLK} - 3.0 + W$         |                        | ns   |
| t <sub>DWHA</sub>   | Address Hold After WR Deasserted                            | H + 0.15                      |                        | ns   |
| t <sub>DWHD</sub>   | Data Hold After WR Deasserted                               | H + 0.02                      |                        | ns   |
| t <sub>DATRWH</sub> | Data Disable After WR Deasserted <sup>4</sup>               | t <sub>SDCLK</sub> - 1.37 + H | $t_{SDCLK} + 4.9 + H$  | ns   |
| t <sub>wwr</sub>    | WR High to WR, RD Low                                       | t <sub>SDCLK</sub> – 1.5 + H  |                        | ns   |
| t <sub>DDWR</sub>   | Data Disable Before RD Low                                  | 2t <sub>SDCLK</sub> – 5.1     |                        | ns   |
| t <sub>WDE</sub>    | WR Low to Data Enabled                                      | t <sub>SDCLK</sub> – 4.1      |                        | ns   |

 $W = (number\ of\ wait\ states\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ AMICTLx\ register) \times t_{SDCLK} \\ H = (number\ of\ hold\ cycles\ specified\ in\ hold\ specified\ in\ hold\ cycles\ specified\ in\ hold\ specified\ in\ hold\ specified\ in\ hold\ specified\ specified\ in\ hold\ specified\ sp$ 

<sup>&</sup>lt;sup>4</sup>See Test Conditions on Page 45 for calculation of hold times given capacitive and dc loads.

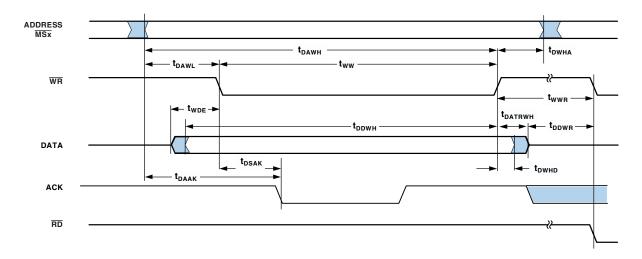


Figure 18. Memory Write—Bus Master

<sup>&</sup>lt;sup>1</sup> ACK delay/setup: System must meet t<sub>DAAK</sub>, or t<sub>DSAK</sub>, for deassertion of ACK (low). For asynchronous assertion of ACK (high) user must meet t<sub>DAAK</sub> or t<sub>DSAK</sub>.

 $<sup>^2</sup>$  The falling edge of  $\overline{MSx}$  is referenced.

 $<sup>^3</sup>$ Note that timing for ACK, DATA,  $\overline{\text{RD}}$ ,  $\overline{\text{WR}}$ , and strobe timing parameters only applies to asynchronous access mode.

#### **Serial Ports**

To determine whether communication is possible between two devices at clock speed n, the following specifications must be confirmed: 1) frame sync delay and frame sync setup and hold, 2) data delay and data setup and hold, and 3) SCLK width.

Serial port signals (SCLK, FS, Data Channel A, Data Channel B) are routed to the DAI\_P20-1 pins using the SRU. Therefore, the timing specifications provided below are valid at the DAI\_P20-1 pins.

Table 29. Serial Ports—External Clock

| Parameter                       |   | Min | Max  | Unit |
|---------------------------------|---|-----|------|------|
| Timing Req                      | uirements   |     |      |      |
| t <sub>SFSE</sub> <sup>1</sup>  | FS Setup Before SCLK (Externally Generated FS in either Transmit or Receive Mode)   | 2.5 |      | ns   |
| t <sub>HFSE</sub> <sup>1</sup>  | FS Hold After SCLK (Externally Generated FS in either Transmit or Receive Mode)     | 2.5 |      | ns   |
| t <sub>SDRE</sub> <sup>1</sup>  | Receive Data Setup Before Receive SCLK  | 2.5 |      | ns   |
| t <sub>HDRE</sub> 1             | Receive Data Hold After SCLK  | 2.5 |      | ns   |
| t <sub>SCLKW</sub>              | SCLK Width  | 10  |      | ns   |
| t <sub>sclk</sub>               | SCLK Period   | 20  |      | ns   |
| Switching C                     | haracteristics  |     |      |      |
| t <sub>DFSE</sub> <sup>2</sup>  | FS Delay After SCLK<br>(Internally Generated FS in either Transmit or Receive Mode) |     | 10.5 | ns   |
| t <sub>HOFSE</sub> <sup>2</sup> | FS Hold After SCLK<br>(Internally Generated FS in either Transmit or Receive Mode)  | 2   |      | ns   |
| t <sub>DDTE</sub> <sup>2</sup>  | Transmit Data Delay After Transmit SCLK   |     | 11   | ns   |
| t <sub>HDTE</sub> <sup>2</sup>  | Transmit Data Hold After Transmit SCLK  | 2   |      | ns   |

<sup>&</sup>lt;sup>1</sup>Referenced to sample edge.

Table 30. Serial Ports—Internal Clock

| Parameter                        |   | Min                      | Max               | Unit |
|----------------------------------|---|--------------------------|-------------------|------|
| Timing Requ                      | irements  |                          |                   |      |
| t <sub>SFSI</sub> <sup>1</sup>   | FS Setup Before SCLK (Externally Generated FS in either Transmit or Receive Mode) | 7                        |                   | ns   |
| t <sub>HFSI</sub> <sup>1</sup>   | FS Hold After SCLK (Externally Generated FS in either Transmit or Receive Mode)   | 2.5                      |                   | ns   |
| $t_{\text{SDRI}}^{}1}$           | Receive Data Setup Before SCLK  | 7                        |                   | ns   |
| $t_{\text{HDRI}}^{}1}$           | Receive Data Hold After SCLK  | 2.5                      |                   | ns   |
| Switching Ch                     | aracteristics   |                          |                   |      |
| $t_{DFSI}^2$                     | FS Delay After SCLK (Internally Generated FS in Transmit Mode)                    |                          | 4                 | ns   |
| t <sub>HOFSI</sub> <sup>2</sup>  | FS Hold After SCLK (Internally Generated FS in Transmit Mode)                     | -1.0                     |                   | ns   |
| t <sub>DFSIR</sub> <sup>2</sup>  | FS Delay After SCLK (Internally Generated FS in Receive Mode)                     |                          | 10.7              | ns   |
| t <sub>HOFSIR</sub> <sup>2</sup> | FS Hold After SCLK (Internally Generated FS in Receive Mode)                      | -1.0                     |                   | ns   |
| $t_{\rm DDTI}^{2}$               | Transmit Data Delay After SCLK  |                          | 3.6               | ns   |
| t <sub>HDTI</sub> <sup>2</sup>   | Transmit Data Hold After SCLK   | -1.0                     |                   | ns   |
| $t_{\text{SCKLIW}}^{3}$          | Transmit or Receive SCLK Width  | 0.5t <sub>SCLK</sub> – 2 | $0.5t_{SCLK} + 2$ | ns   |

<sup>&</sup>lt;sup>1</sup>Referenced to the sample edge.

<sup>&</sup>lt;sup>2</sup>Referenced to drive edge.

<sup>&</sup>lt;sup>2</sup>Referenced to drive edge.

<sup>&</sup>lt;sup>3</sup> Minimum SPORT divisor register value.

### Table 31. Serial Ports—Enable and Three-State

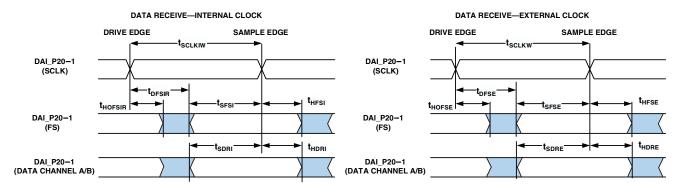
| Parameter                 |  | Min | Max | Unit |
|---------------------------|--|-----|-----|------|
| Switching Characteristics |  |     |     |      |
| $t_{\text{DDTEN}}^{-1}$   | Data Enable from External Transmit SCLK  | 2   |     | ns   |
| $t_{\text{DDTTE}}^{1}$    | Data Disable from External Transmit SCLK |     | 10  | ns   |
| $t_{DDTIM}^{1}$           | Data Enable from Internal Transmit SCLK  | -1  |     | ns   |

 $<sup>^{1}\</sup>mathrm{Referenced}$  to drive edge.

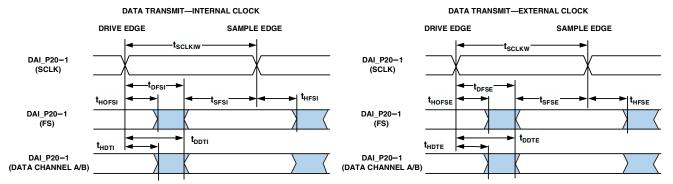
### Table 32. Serial Ports—External Late Frame Sync

| Parameter                         |   | Min | Max | Unit |
|-----------------------------------|---|-----|-----|------|
| Switching Char                    | acteristics   |     |     |      |
| t <sub>DDTLFSE</sub> <sup>1</sup> | Data Delay from Late External Transmit FS or External Receive FS with MCE $= 1$ , MFD $= 0$ |     | 10  | ns   |
| t <sub>DDTENFS</sub> <sup>1</sup> | Data Enable for MCE = 1, MFD = 0  | 0.5 |     | ns   |

 $<sup>^{1}\</sup>text{The }t_{\text{DDTLESE}}\text{ and }t_{\text{DDTENFS}}\text{ parameters apply to left-justified sample pair as well as DSP serial mode, and MCE}=1, \text{MFD}=0.$ 



NOTE: EITHER THE RISING EDGE OR FALLING EDGE OF SCLK (EXTERNAL) OR SCLK (INTERNAL) CAN BE USED AS THE ACTIVE SAMPLING EDGE.



NOTE: EITHER THE RISING EDGE OR FALLING EDGE OF SCLK (EXTERNAL) OR SCLK (INTERNAL) CAN BE USED AS THE ACTIVE SAMPLING EDGE.

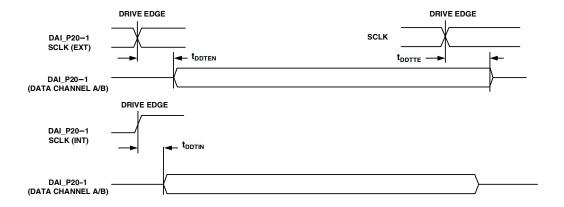
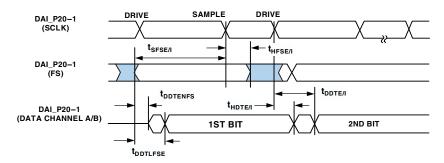
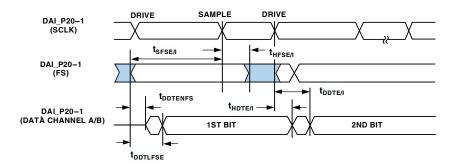


Figure 19. Serial Ports

### EXTERNAL RECEIVE FS WITH MCE = 1, MFD = 0



#### LATE EXTERNAL TRANSMIT FS



NOTE: SERIAL PORT SIGNALS (SCLK, FS, DATA CHANNEL A/B) ARE ROUTED TO THE DAI\_P20-1 PINS USING THE SRU. THE TIMING SPECIFICATIONS PROVIDED HERE ARE VALID AT THE DAI\_P20-1 PINS. THE CHARACTERIZED AC SPORT TIMINGS ARE APPLICABLE WHEN INTERNAL CLOCKS AND FRAMES ARE LOOPED BACK FROM THE PIN,NOT ROUTED DIRECTLY THROUGH SRU.

Figure 20. External Late Frame Sync<sup>1</sup>

 $<sup>^{\</sup>rm 1}{\rm This}$  figure reflects changes made to support left-justified sample pair mode.

### Input Data Port (IDP)

The timing requirements for the IDP are given in Table 33. IDP signals (SCLK, FS, and SDATA) are routed to the DAI\_P20-1 pins using the SRU. Therefore, the timing specifications provided below are valid at the DAI\_P20-1 pins.

Table 33. Input Data Port (IDP)

| Parameter Timing Requirements |                                     | Min | Max | Unit |
|-------------------------------|-------------------------------------|-----|-----|------|
|                               |                                     |     |     |      |
| $t_{SISFS}^{1}$               | FS Setup Before SCLK Rising Edge    | 3.8 |     | ns   |
| t <sub>SIHFS</sub> 1          | FS Hold After SCLK Rising Edge      | 2.5 |     | ns   |
| $t_{SISD}^{1}$                | SData Setup Before SCLK Rising Edge | 2.5 |     | ns   |
| t <sub>SIHD</sub> 1           | SData Hold After SCLK Rising Edge   | 2.5 |     | ns   |
| t <sub>IDPCLKW</sub>          | Clock Width                         | 9   |     | ns   |
| t <sub>IDPCLK</sub>           | Clock Period                        | 24  |     | ns   |

<sup>1</sup> DATA, SCLK, FS can come from any of the DAI pins. SCLK and FS can also come via PCG or SPORTs. PCG's input can be either CLKIN or any of the DAI pins.

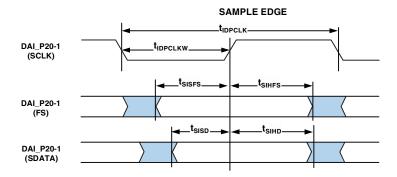


Figure 21. IDP Master Timing

### Parallel Data Acquisition Port (PDAP)

The timing requirements for the PDAP are provided in Table 34. PDAP is the parallel mode operation of Channel 0 of the IDP. For details on the operation of the PDAP, see the PDAP chapter of the *ADSP-21368 SHARC Processor Hardware* 

Reference. Note that the most significant 16 bits of external PDAP data can be provided through the DATA31–16 pins. The remaining four bits can only be sourced through DAI\_P4–1. The timing below is valid at the DATA31–16 pins.

Table 34. Parallel Data Acquisition Port (PDAP)

| Parameter                      |  | Min                     | Max | Unit |
|--------------------------------|--|-------------------------|-----|------|
| Timing Requir                  | rements  |                         |     |      |
| t <sub>SPCLKEN</sub> 1         | PDAP_CLKEN Setup Before PDAP_CLK Sample Edge                     | 2.5                     |     | ns   |
| t <sub>HPCLKEN</sub> 1         | PDAP_CLKEN Hold After PDAP_CLK Sample Edge                       | 2.5                     |     | ns   |
| t <sub>PDSD</sub> <sup>1</sup> | PDAP_DAT Setup Before SCLK PDAP_CLK Sample Edge                  | 3.85                    |     | ns   |
| t <sub>PDHD</sub> 1            | PDAP_DAT Hold After SCLK PDAP_CLK Sample Edge                    | 2.5                     |     | ns   |
| t <sub>PDCLKW</sub>            | Clock Width  | 7                       |     | ns   |
| t <sub>PDCLK</sub>             | Clock Period   | 24                      |     | ns   |
| Switching Cha                  | aracteristics  |                         |     |      |
| t <sub>PDHLDD</sub>            | Delay of PDAP Strobe After Last PDAP_CLK Capture Edge for a Word | $2 \times t_{PCLK} + 3$ |     | ns   |
| t <sub>PDSTRIB</sub>           | PDAP Strobe Pulse Width  | $2 \times t_{PCLK} - 1$ |     | ns   |

<sup>1</sup> Source pins of DATA are DATA31-12 or DAI pins. Source pins for SCLK and FS are: 1) DAI pins, 2) CLKIN through PCG, or 3) DAI pins through PCG.

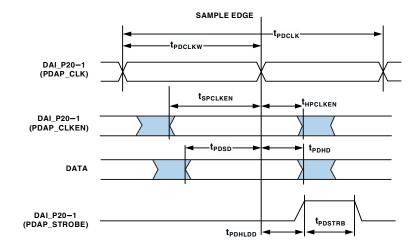


Figure 22. PDAP Timing

### **Pulse-Width Modulation Generators (PWM)**

For the ADSP-21371, the following timing specifications apply when the DATA31–16 pins are configured as PWM.

Pulse-Width Modulation Generator information does not apply to the ADSP-21375.

Table 35. Pulse-Width Modulation (PWM) Timing

| Parameter                 |                        | Min                       | Max                              | Unit |
|---------------------------|------------------------|---------------------------|----------------------------------|------|
| Switching Characteristics |                        |                           |                                  |      |
| $t_{\text{PWMW}}$         | PWM Output Pulse Width | $t_{PCLK} - 2.5$          | $(2^{16}-2) \times t_{PCLK}-2.5$ | ns   |
| t <sub>PWMP</sub>         | PWM Output Period      | $2 \times t_{PCLK} - 2.5$ | $(2^{16}-1) \times t_{PCLK}-2.5$ | ns   |

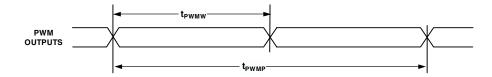


Figure 23. PWM Timing

#### S/PDIF Transmitter

For the ADSP-21371, serial data input to the S/PDIF transmitter can be formatted as left justified,  $\rm I^2S$ , or right justified with word widths of 16-, 18-, 20-, or 24-bits. The following sections provide timing for the transmitter.

#### S/PDIF Transmitter-Serial Input Waveforms

Figure 24 shows the right-justified mode. LRCLK is HI for the left channel and LO for the right channel. Data is valid on the rising edge of SCLK. The MSB is delayed 12-bit clock periods (in 20-bit output mode) or 16-bit clock periods (in 16-bit output

mode) from an LRCLK transition, so that when there are 64 SCLK periods per LRCLK period, the LSB of the data will be right-justified to the next LRCLK transition.

S/PDIF Transmitter information does not apply to the ADSP-21375.

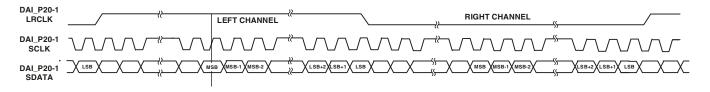


Figure 24. Right-Justified Mode

Figure 25 shows the default I<sup>2</sup>S-justified mode. LRCLK is LO for the left channel and HI for the right channel. Data is valid on the rising edge of SCLK. The MSB is left-justified to an LRCLK transition but with a single SCLK period delay.

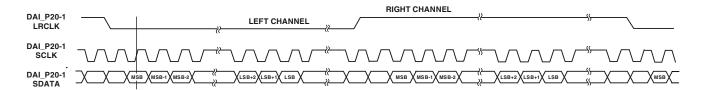


Figure 25. 1<sup>2</sup>S-Justified Mode

Figure 26 shows the left-justified mode. LRCLK is HI for the left channel and LO for the right channel. Data is valid on the rising edge of SCLK. The MSB is left-justified to an LRCLK transition with no MSB delay.

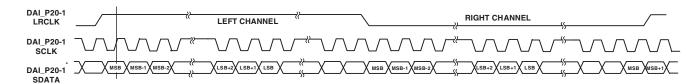


Figure 26. Left-Justified Mode

#### **S/PDIF Transmitter Input Data Timing**

The timing requirements for the S/PDIF transmitter are given in Table 36. Input signals (SCLK, FS, SDATA) are routed to the DAI\_P20-1 pins using the SRU. Therefore, the timing specifications provided below are valid at the DAI\_P20-1 pins.

Table 36. S/PDIF Transmitter Input Data Timing

| Parameter               |                                     | Min | Max | Unit |
|-------------------------|-------------------------------------|-----|-----|------|
| Timing Requ             | iming Requirements                  |     |     |      |
| $t_{SISFS}^{1}$         | FS Setup Before SCLK Rising Edge    | 3   |     | ns   |
| $t_{\text{SIHRS}}^{-1}$ | FS Hold After SCLK Rising Edge      | 3   |     | ns   |
| $t_{SISD}^{-1}$         | SData Setup Before SCLK Rising Edge | 3   |     | ns   |
| $t_{\text{SIHD}}^{}1}$  | SData Hold After SCLK Rising Edge   | 3   |     | ns   |
| t <sub>SITXCLKW</sub>   | Transmit Clock Width                | 9   |     | ns   |
| t <sub>SITXCLK</sub>    | Transmit Clock Period               | 20  |     | ns   |
| $t_{\text{SISCLKW}}$    | Clock Width                         | 36  |     | ns   |
| t <sub>SISCLK</sub>     | Clock Period                        | 80  |     | ns   |

<sup>1</sup> DATA, SCLK, FS can come from any of the DAI pins. SCLK and FS can also come via PCG or SPORTs. PCG's input can be either CLKIN or any of the DAI pins.

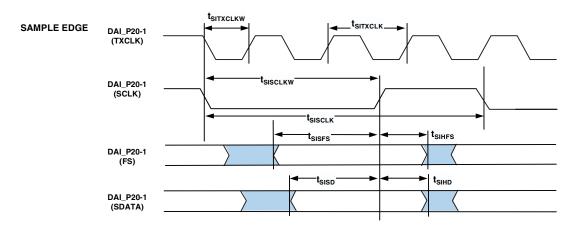


Figure 27. S/PDIF Transmitter Input Timing

#### Oversampling Clock (TxCLK) Switching Characteristics

The S/PDIF transmitter has an oversampling clock. This TxCLK input is divided down to generate the biphase clock.

Table 37. Oversampling Clock (TxCLK) Switching Characteristics

| Parameter                                   | Min | Max   | Unit |
|---|-----|-------|------|
| TxCLK Frequency for TxCLK = $384 \times FS$ | ,   | 73.8  | MHz  |
| TxCLK Frequency for TxCLK = $256 \times FS$ |     | 49.2  | MHz  |
| Frame Rate                                  |     | 192.0 | kHz  |

#### S/PDIF Receiver

For the ADSP-21371, the following section describes timing as it relates to the S/PDIF receiver.

#### **Internal Digital PLL Mode**

In the internal digital phase-locked loop mode the internal PLL (digital PLL) generates the  $512 \times FS$  clock.

S/PDIF Transmitter information does not apply to the ADSP-21375.

Table 38. S/PDIF Receiver Internal Digital PLL Mode Timing

| Parameter                 |                                |      | Max | Unit |  |
|---------------------------|--------------------------------|------|-----|------|--|
| Switching Characteristics |                                |      |     |      |  |
| t <sub>DFSI</sub>         | LRCLK Delay After SCLK         |      | 5   | ns   |  |
| t <sub>HOFSI</sub>        | LRCLK Hold After SCLK          | -2   |     | ns   |  |
| t <sub>DDTI</sub>         | Transmit Data Delay After SCLK |      | 5   | ns   |  |
| t <sub>HDTI</sub>         | Transmit Data Hold After SCLK  | -2   |     | ns   |  |
| t <sub>SCLKIW</sub> 1     | Transmit SCLK Width            | 38.5 |     | ns   |  |

 $<sup>^{1}</sup>$  SCLK frequency is 64 × FS where FS = the frequency of LRCLK.

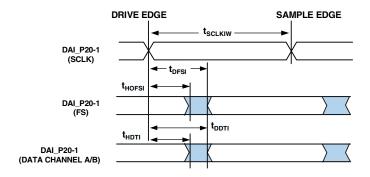


Figure 28. S/PDIF Receiver Internal Digital PLL Mode Timing

#### SPI Interface—Master

The ADSP-21371/ADSP-21375 contains two SPI ports. Both primary and secondary are available through DPI only. The timing provided in Table 39 and Table 40 applies to both.

Table 39. SPI Interface Protocol—Master Switching and Timing Specifications

| Parameter            |   | Min                     | Max | Unit |
|----------------------|---|-------------------------|-----|------|
| Timing Require       | ments   |                         |     |      |
| t <sub>SSPIDM</sub>  | Data Input Valid To SPICLK Edge (Data Input Setup Time) | 8.2                     |     | ns   |
| t <sub>HSPIDM</sub>  | SPICLK Last Sampling Edge To Data Input Not Valid       | 2                       |     | ns   |
| Switching Char       | acteristics   |                         |     |      |
| t <sub>SPICLKM</sub> | Serial Clock Cycle                                      | $8 \times t_{PCLK} - 2$ |     | ns   |
| t <sub>SPICHM</sub>  | Serial Clock High Period                                | $4 \times t_{PCLK} - 2$ |     | ns   |
| t <sub>SPICLM</sub>  | Serial Clock Low Period                                 | $4 \times t_{PCLK} - 2$ |     | ns   |
| t <sub>DDSPIDM</sub> | SPICLK Edge to Data Out Valid (Data Out Delay Time)     |                         | 2.5 | ns   |
| t <sub>HDSPIDM</sub> | SPICLK Edge to Data Out Not Valid (Data Out Hold Time)  | $4 \times t_{PCLK} - 2$ |     | ns   |
| t <sub>SDSCIM</sub>  | FLAG3-0IN (SPI device select) Low to First SPICLK Edge  | $4 \times t_{PCLK} - 2$ |     | ns   |
| t <sub>HDSM</sub>    | Last SPICLK Edge to FLAG3–0IN High                      | $4 \times t_{PCLK} - 2$ |     | ns   |
| t <sub>SPITDM</sub>  | Sequential Transfer Delay                               | $4 \times t_{PCLK} - 1$ |     | ns   |

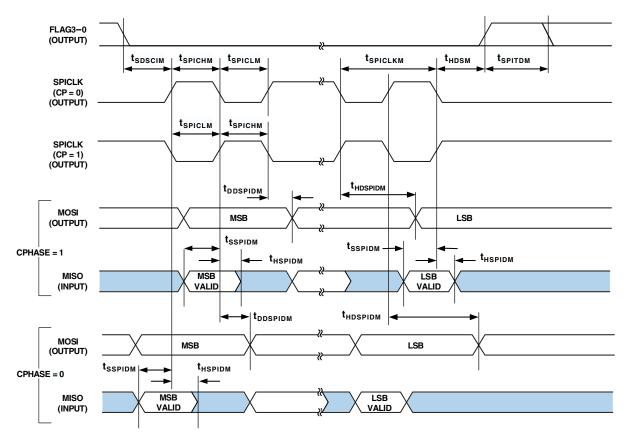


Figure 29. SPI Master Timing

#### SPI Interface—Slave

Table 40. SPI Interface Protocol—Slave Switching and Timing Specifications

| Parameter            |  | Min                     | Max                 | Unit |
|----------------------|--|-------------------------|---------------------|------|
| Timing Require       | ments  |                         |                     |      |
| t <sub>SPICLKS</sub> | Serial Clock Cycle   | $4 \times t_{PCLK} - 2$ |                     | ns   |
| t <sub>SPICHS</sub>  | Serial Clock High Period   | $2 \times t_{PCLK} - 2$ |                     | ns   |
| t <sub>SPICLS</sub>  | Serial Clock Low Period  | $2 \times t_{PCLK} - 2$ |                     | ns   |
| t <sub>SDSCO</sub>   | SPIDS Assertion to First SPICLK Edge                               |                         |                     | ns   |
|                      | CPHASE = 0   | $2 \times t_{PCLK}$     |                     |      |
|                      | CPHASE = 1   | $2 \times t_{PCLK}$     |                     |      |
| t <sub>HDS</sub>     | Last SPICLK Edge to SPIDS Not Asserted, CPHASE=0                   | $2 \times t_{PCLK}$     |                     | ns   |
| t <sub>SSPIDS</sub>  | Data Input Valid to SPICLK edge (Data Input Set-up Time)           | 2                       |                     | ns   |
| t <sub>HSPIDS</sub>  | SPICLK Last Sampling Edge to Data Input Not Valid                  | 2                       |                     | ns   |
| t <sub>SDPPW</sub>   | SPIDS Deassertion Pulse Width (CPHASE=0)                           | $2 \times t_{PCLK}$     |                     | ns   |
| Switching Char       | acteristics  |                         |                     |      |
| t <sub>DSOE</sub>    | SPIDS Assertion to Data Out Active                                 | 0                       | 6.8                 | ns   |
| t <sub>DSDHI</sub>   | SPIDS Deassertion to Data High Impedance                           | 0                       | 6.8                 | ns   |
| t <sub>DDSPIDS</sub> | SPICLK Edge to Data Out Valid (Data Out Delay Time)                |                         | 9.5                 | ns   |
| t <sub>HDSPIDS</sub> | SPICLK Edge to Data Out Not Valid (Data Out Hold Time)             | $2 \times t_{PCLK}$     |                     | ns   |
| t <sub>DSOV</sub>    | $\overline{\text{SPIDS}}$ Assertion to Data Out Valid (CPHASE = 0) |                         | $5 \times t_{PCLK}$ | ns   |

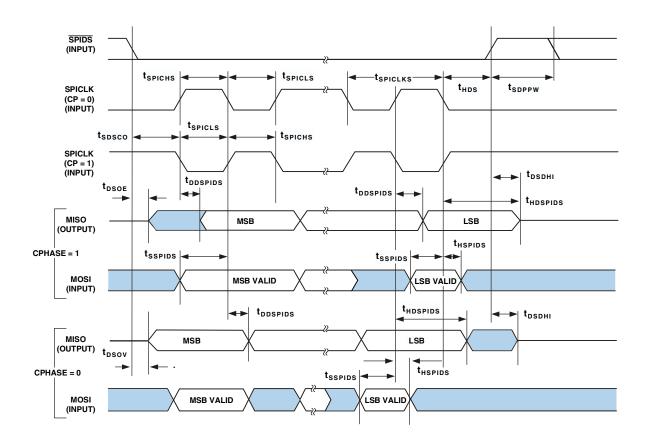


Figure 30. SPI Slave Timing

# Universal Asynchronous Receiver-Transmitter (UART) Port—Receive and Transmit Timing

Figure 31 describes UART port receive and transmit operations. The maximum baud rate is PCLK/16 where PCLK =  $1/t_{PCLK}$ . As shown in Figure 31 there is some latency between the genera-

tion of internal UART interrupts and the external data operations. These latencies are negligible at the data transmission rates for the UART.

Table 41. UART Port

| Parameter      |                           | Min | Max | Unit |
|----------------|---------------------------|-----|-----|------|
| Timing Requir  | rement                    |     |     |      |
| $t_{TXD}^{-1}$ | Incoming Data Pulse Width | ≥95 |     | ns   |
| Switching Cha  | aracteristic              |     |     |      |
| $t_{RXD}^{1}$  | Incoming Data Pulse Width | ≥95 |     | ns   |

<sup>&</sup>lt;sup>1</sup>UART signals TXD and RXD are routed through DPI P14-1 pins using the SRU.

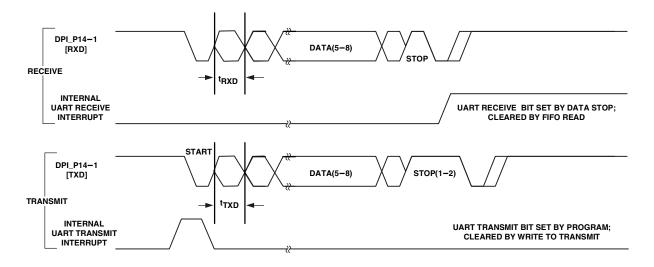


Figure 31. UART Port—Receive and Transmit Timing

#### TWI Controller Timing

Table 42 and Figure 32 provide timing information for the TWI interface. Input Signals (SCL, SDA) are routed to the DPI\_P14-1 pins using the SRU. Therefore, the timing specifications provided below are valid at the DPI\_P14-1 pins.

Table 42. Characteristics of the SDA and SCL Bus Lines for F/S-Mode TWI Bus Devices<sup>1</sup>

|                    |  | S   | tandard Mode | Fa  | ast Mode |      |
|--------------------|--|-----|--------------|-----|----------|------|
| Parameter          |  | Min | Max          | Min | Max      | Unit |
| f <sub>SCL</sub>   | SCL Clock Frequency  | 0   | 100          | 0   | 400      | kHz  |
| t <sub>HDSTA</sub> | Hold Time (repeated) Start Condition. After This Period, the First Clock Pulse is Generated. | 4.0 |              | 0.6 |          | μs   |
| $t_{LOW}$          | Low Period of the SCL Clock  | 4.7 |              | 1.3 |          | μs   |
| t <sub>HIGH</sub>  | High Period of the SCL Clock   | 4.0 |              | 0.6 |          | μs   |
| t <sub>SUSTA</sub> | Setup Time for a Repeated Start Condition  | 4.7 |              | 0.6 |          | μs   |
| t <sub>HDDAT</sub> | Data Hold Time for TWI-bus Devices   | 0   |              | 0   |          | μs   |
| t <sub>SUDAT</sub> | Data Setup Time  | 250 |              | 100 |          | ns   |
| t <sub>SUSTO</sub> | Setup Time for Stop Condition  | 4.0 |              | 0.6 |          | μs   |
| t <sub>BUF</sub>   | Bus Free Time Between a Stop and Start Condition   | 4.7 |              | 1.3 |          | μs   |
| t <sub>SP</sub>    | Pulse Width of Spikes Suppressed By the Input Filter   | n/a | n/a          | 0   | 50       | ns   |

 $<sup>^1</sup>$  All values referred to  $V_{IHmin}$  and  $V_{ILmax}$  levels. For more information, see Electrical Characteristics on page 16.

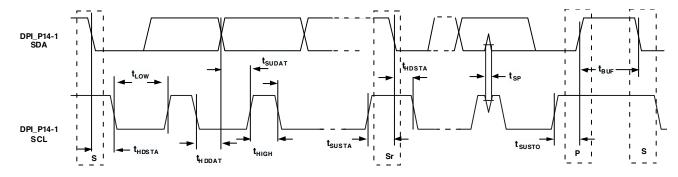


Figure 32. Fast and Standard Mode Timing on the TWI Bus

#### **JTAG Test Access Port and Emulation**

Table 43. JTAG Test Access Port and Emulation

| Parameter              | Unit                                |                  |                  |    |
|------------------------|-------------------------------------|------------------|------------------|----|
| Timing Req             | uirements                           |                  |                  |    |
| $t_{\text{TCK}}$       | TCK Period                          | t <sub>CK</sub>  |                  | ns |
| $t_{STAP}$             | TDI, TMS Setup Before TCK High      | 5                |                  | ns |
| t <sub>HTAP</sub>      | TDI, TMS Hold After TCK High        | 6                |                  | ns |
| $t_{SSYS}^{1}$         | System Inputs Setup Before TCK High | 7                |                  | ns |
| $t_{\text{HSYS}}^{-1}$ | System Inputs Hold After TCK High   | 18               |                  | ns |
| $t_{TRSTW}$            | TRST Pulse Width                    | $4 	imes t_{CK}$ |                  | ns |
| Switching C            | Characteristics                     |                  |                  |    |
| $t_{DTDO}$             | TDO Delay from TCK Low              |                  | 7                | ns |
| $t_{\text{DSYS}}^{2}$  | System Outputs Delay After TCK Low  |                  | $t_{CK} / 2 + 7$ | ns |

 $<sup>^{1}</sup> System\ Inputs = AD15-0,\ CLKCFG1-0,\ \overline{RESET},\ BOOTCFG1-0,\ DAI\_Px,\ and\ FLAG3-0.$   $^{2} System\ Outputs = DAI\_Px,\ AD15-0,\ \overline{RD},\ \overline{WR},\ FLAG3-0,\ CLKOUT,\ \overline{EMU},\ and\ ALE.$ 

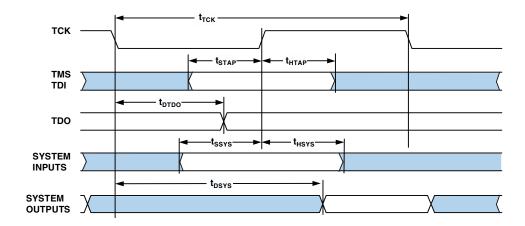


Figure 33. IEEE 1149.1 JTAG Test Access Port

#### **OUTPUT DRIVE CURRENTS**

Figure 34 shows typical I-V characteristics for the output drivers of the ADSP-21371/ADSP-21375. The curves represent the current drive capability of the output drivers as a function of output voltage.

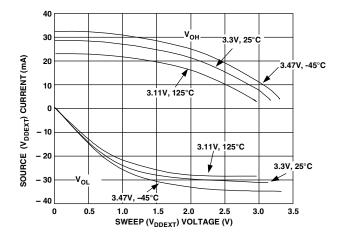


Figure 34. ADSP-21371/ADSP-21375 Typical Drive at Junction Temperature

#### **TEST CONDITIONS**

The ac signal specifications (timing parameters) appear in Table 17 on Page 22 through Table 43 on Page 44. These include output disable time, output enable time, and capacitive loading. The timing specifications for the SHARC apply for the voltage reference levels in Figure 35.

Timing is measured on signals when they cross the 1.5 V level as described in Figure 36. All delays (in nanoseconds) are measured between the point that the first signal reaches 1.5 V and the point that the second signal reaches 1.5 V.

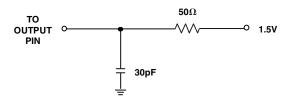


Figure 35. Equivalent Device Loading for AC Measurements (Includes All Fixtures)



Figure 36. Voltage Reference Levels for AC Measurements

#### CAPACITIVE LOADING

Output delays and holds are based on standard capacitive loads: 30 pF on all pins (see Figure 35). Figure 39 shows graphically how output delays and holds vary with load capacitance. The graphs of Figure 37, Figure 38, and Figure 39 may not be linear outside the ranges shown for Typical Output Delay vs. Load Capacitance and Typical Output Rise Time (20% to 80%, V = Min) vs. Load Capacitance.

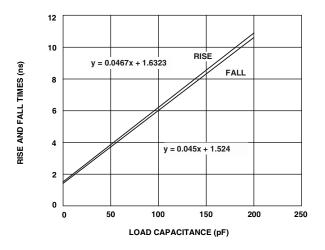


Figure 37. Typical Output Rise/Fall Time (20% to 80%,  $V_{DDEXT} = Max$ )

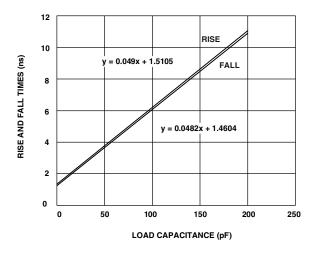


Figure 38. Typical Output Rise/Fall Time (20% to 80%,  $V_{DDEXT} = Min$ )

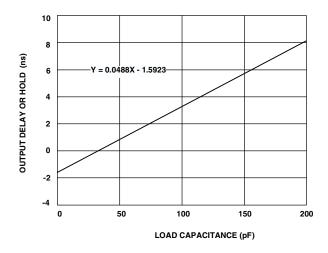


Figure 39. Typical Output Delay or Hold vs. Load Capacitance (at Ambient Temperature)

#### THERMAL CHARACTERISTICS

The ADSP-21371/ADSP-21375 processor is rated for performance over the temperature range specified in Operating Conditions on Page 16.

Table 44 airflow measurements comply with JEDEC standards JESD51-2 and JESD51-6 and the junction-to-board measurement complies with JESD51-8. Test board design complies with JEDEC standards JESD51-7 (MQFP). The junction-to-case measurement complies with MIL- STD-883. All measurements use a 2S2P JEDEC test board.

To determine the junction temperature of the device while on the application PCB, use

$$T_J = T_{CASE} + (\Psi_{JT} \times P_D)$$

where:

 $T_I$  = junction temperature °C

 $T_{CASE}$  = case temperature (°C) measured at the top center of the package

 $\Psi_{JT}$  = junction-to-top (of package) characterization parameter is the Typical value from Table 44.

 $P_D$  = power dissipation

Values of  $\theta_{JA}$  are provided for package comparison and PCB design considerations.  $\theta_{JA}$  can be used for a first order approximation of  $T_J$  by the equation

$$T_J = T_A + (\theta_{JA} \times P_D)$$

where:

 $T_A$  = ambient temperature °C

Values of  $\theta_{JC}$  are provided for package comparison and PCB design considerations when an external heatsink is required.

Values of  $\theta_{JB}$  are provided for package comparison and PCB design considerations. Note that the thermal characteristics values provided in Table 44 are modeled values.

Table 44. Thermal Characteristics for 208-Lead MQFP

| Parameter           | Condition                 | Typical | Unit |
|---------------------|---------------------------|---------|------|
| $\theta_{JA}$       | Airflow = 0 m/s           | 30.82   | °C/W |
| $\theta_{JMA}$      | Airflow = $1 \text{ m/s}$ | 27.53   | °C/W |
| $\theta_{JMA}$      | Airflow = 2 m/s           | 26.22   | °C/W |
| $\theta_{JC}$       |                           | 14.04   | °C/W |
| $\Psi_{	extsf{JT}}$ | Airflow = 0 m/s           | 2.0     | °C/W |
| $\Psi_{JMT}$        | Airflow = 1 m/s           | 2.65    | °C/W |
| $\Psi_{JMT}$        | Airflow = 2 m/s           | 3.12    | °C/W |

## **208-LEAD MQFP PINOUT**

Table 45. ADSP-21371, 208-Lead MQFP Pin Assignment (Numerically by Lead Number)

| Pin No.  | Signal             | Pin No. | Signal             | Pin No. | Signal                    | Pin No. | Signal                    |
|----------|--------------------|---------|--------------------|---------|---------------------------|---------|---------------------------|
| 1        | V <sub>DDINT</sub> | 53      | V <sub>DDINT</sub> | 105     | V <sub>DDINT</sub>        | 157     | V <sub>DDINT</sub>        |
| 2        | DATA28             | 54      | GND                | 106     | GND                       | 158     | $V_{\text{DDINT}}$        |
| 3        | DATA27             | 55      | $V_{\text{DDEXT}}$ | 107     | $V_{\text{DDEXT}}$        | 159     | GND                       |
| 4        | GND                | 56      | ADDR0              | 108     | SDCAS                     | 160     | $V_{\text{DDINT}}$        |
| 5        | $V_{\text{DDEXT}}$ | 57      | ADDR2              | 109     | SDRAS                     | 161     | $V_{\text{DDINT}}$        |
| 6        | DATA26             | 58      | ADDR1              | 110     | SDCKE                     | 162     | $V_{\text{DDINT}}$        |
| 7        | DATA25             | 59      | ADDR4              | 111     | SDWE                      | 163     | TDI                       |
| 8        | DATA24             | 60      | ADDR3              | 112     | WR                        | 164     | TRST                      |
| 9        | DATA23             | 61      | ADDR5              | 113     | SDA10                     | 165     | TCK                       |
| 10       | GND                | 62      | GND                | 114     | GND                       | 166     | GND                       |
| 11       | $V_{\text{DDINT}}$ | 63      | $V_{\text{DDINT}}$ | 115     | $V_{\text{DDEXT}}$        | 167     | $V_{\text{DDINT}}$        |
| 12       | DATA22             | 64      | GND                | 116     | SDCLK                     | 168     | TMS                       |
| 13       | DATA21             | 65      | $V_{\text{DDEXT}}$ | 117     | GND                       | 169     | CLK_CFG0                  |
| 14       | DATA20             | 66      | ADDR6              | 118     | $V_{\text{DDINT}}$        | 170     | BOOTCFG0                  |
| 15       | $V_{\text{DDEXT}}$ | 67      | ADDR7              | 119     | RD                        | 171     | CLK_CFG1                  |
| 16       | GND                | 68      | ADDR8              | 120     | ACK                       | 172     | EMU                       |
| 17       | DATA19             | 69      | ADDR9              | 121     | FLAG3                     | 173     | BOOTCFG1                  |
| 18       | DATA18             | 70      | ADDR10             | 122     | FLAG2                     | 174     | TDO                       |
| 19       | $V_{DDINT}$        | 71      | GND                | 123     | FLAG1                     | 175     | DAI4                      |
| 20       | GND                | 72      | V <sub>DDINT</sub> | 124     | FLAG0                     | 176     | DAI2                      |
| 21       | DATA17             | 73      | GND                | 125     | DAI20                     | 177     | DAI3                      |
| 22       | $V_{\text{DDINT}}$ | 74      | $V_{DDEXT}$        | 126     | GND                       | 178     | DAI1                      |
| 23       | GND                | 75      | ADDR11             | 127     | $V_{DDINT}$               | 179     | $V_{DDEXT}$               |
| 24       | V <sub>DDINT</sub> | 76      | ADDR12             | 128     | GND                       | 180     | GND                       |
| 25       | GND                | 77      | ADDR13             | 129     | $V_{DDEXT}$               | 181     | $V_{DDINT}$               |
| 26       | DATA16             | 78      | GND                | 130     | DAI19                     | 182     | GND                       |
| 27       | DATA15             | 79      | V <sub>DDINT</sub> | 131     | DAI18                     | 183     | DPI14                     |
| 28       | DATA14             | 80      | NC                 | 132     | DAI17                     | 184     | DPI13                     |
| 29       | DATA13             | 81      | NC                 | 133     | DAI16                     | 185     | DPI12                     |
| 30       | DATA12             | 82      | GND                | 134     | DAI15                     | 186     | DPI11                     |
| 31       | V <sub>DDEXT</sub> | 83      | CLKIN              | 135     | DAI14                     | 187     | DPI10                     |
| 32       | GND                | 84      | XTAL               | 136     | DAI13                     | 188     | DPI9                      |
| 33       | V <sub>DDINT</sub> | 85      | V <sub>DDEXT</sub> | 137     | DAI12                     | 189     | DPI8                      |
| 34       | GND                | 86      | GND                | 138     | V <sub>DDINT</sub>        | 190     | DPI7                      |
| 35       | DATA11             | 87      | V <sub>DDINT</sub> | 139     | V <sub>DDEXT</sub>        | 191     | V <sub>DDEXT</sub>        |
| 36       | DATA11             | 88      | ADDR14             | 140     | GND                       | 192     | GND                       |
| 37       | DATA10<br>DATA9    | 89      | GND                | 141     |                           |         |                           |
| 38       | DATA9<br>DATA8     | 90      |                    |         | V <sub>DDINT</sub><br>GND | 193     | V <sub>DDINT</sub><br>GND |
|          |                    |         | V <sub>DDEXT</sub> | 142     |                           | 194     |                           |
| 39<br>40 | DATA 6             | 91      | ADDR16             | 143     | DAI11                     | 195     | DPI6                      |
| 40       | DATA6              | 92      | ADDR16             | 144     | DAI10                     | 196     | DPI5                      |
| 41       | V <sub>DDEXT</sub> | 93      | ADDR17             | 145     | DAI8                      | 197     | DPI4                      |
| 42       | GND                | 94      | ADDR18             | 146     | DAI9                      | 198     | DPI3                      |
| 43       | V <sub>DDINT</sub> | 95      | GND                | 147     | DAI6                      | 199     | DPI1                      |
| 44       | DATA4              | 96      | $V_{DDEXT}$        | 148     | DAI7                      | 200     | DPI2                      |

Table 45. ADSP-21371, 208-Lead MQFP Pin Assignment (Numerically by Lead Number) (Continued)

| Pin No. | Signal      | Pin No. | Signal             | Pin No. | Signal             | Pin No. | Signal             |
|---------|-------------|---------|--------------------|---------|--------------------|---------|--------------------|
| 45      | DATA5       | 97      | ADDR19             | 149     | DAI5               | 201     | CLKOUT/            |
|         |             |         |                    |         |                    |         | ~RESETOUT/         |
|         |             |         |                    |         |                    |         | ~RUNRSTIN          |
| 46      | DATA2       | 98      | ADDR20             | 150     | $V_{\text{DDEXT}}$ | 202     | RESET              |
| 47      | DATA3       | 99      | ADDR21             | 151     | GND                | 203     | $V_{\text{DDEXT}}$ |
| 48      | DATA0       | 100     | ADDR23             | 152     | $V_{DDINT}$        | 204     | GND                |
| 49      | DATA1       | 101     | ADDR22             | 153     | GND                | 205     | DATA30             |
| 50      | $V_{DDEXT}$ | 102     | MS1                | 154     | $V_{DDINT}$        | 206     | DATA31             |
| 51      | GND         | 103     | MS0                | 155     | GND                | 207     | DATA29             |
| 52      | $V_{DDINT}$ | 104     | $V_{\text{DDINT}}$ | 156     | $V_{DDINT}$        | 208     | $V_{DDINT}$        |

Table 46. ADSP-21375, 208-Lead MQFP Pin Assignment (Numerically by Lead Number)

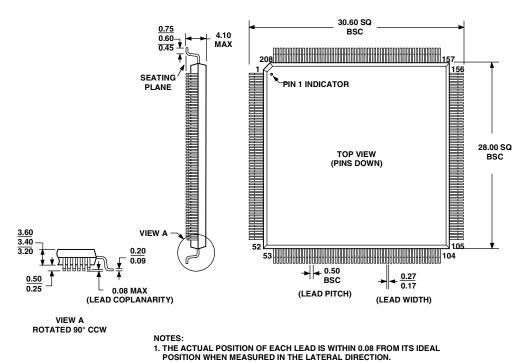
| Pin No. | Signal             |
|---------|--------------------|---------|--------------------|---------|--------------------|---------|--------------------|
| 1       | V <sub>DDINT</sub> | 53      | V <sub>DDINT</sub> | 105     | V <sub>DDINT</sub> | 157     | V <sub>DDINT</sub> |
| 2       | NC                 | 54      | GND                | 106     | GND                | 158     | $V_{\text{DDINT}}$ |
| 3       | NC                 | 55      | $V_{DDEXT}$        | 107     | $V_{\text{DDEXT}}$ | 159     | GND                |
| 4       | GND                | 56      | ADDR0              | 108     | SDCAS              | 160     | $V_{\text{DDINT}}$ |
| 5       | $V_{\text{DDEXT}}$ | 57      | ADDR2              | 109     | SDRAS              | 161     | V <sub>DDINT</sub> |
| 6       | NC                 | 58      | ADDR1              | 110     | SDCKE              | 162     | $V_{DDINT}$        |
| 7       | NC                 | 59      | ADDR4              | 111     | SDWE               | 163     | TDI                |
| 8       | NC                 | 60      | ADDR3              | 112     | WR                 | 164     | TRST               |
| 9       | NC                 | 61      | ADDR5              | 113     | SDA10              | 165     | TCK                |
| 10      | GND                | 62      | GND                | 114     | GND                | 166     | GND                |
| 11      | $V_{\text{DDINT}}$ | 63      | $V_{DDINT}$        | 115     | $V_{DDEXT}$        | 167     | $V_{\text{DDINT}}$ |
| 12      | NC                 | 64      | GND                | 116     | SDCLK              | 168     | TMS                |
| 13      | NC                 | 65      | $V_{DDEXT}$        | 117     | GND                | 169     | CLK_CFG0           |
| 14      | NC                 | 66      | ADDR6              | 118     | $V_{DDINT}$        | 170     | BOOTCFG0           |
| 15      | NC                 | 67      | ADDR7              | 119     | RD                 | 171     | CLK_CFG1           |
| 16      | NC                 | 68      | ADDR8              | 120     | ACK                | 172     | EMU                |
| 17      | NC                 | 69      | ADDR9              | 121     | FLAG3              | 173     | BOOTCFG1           |
| 18      | NC                 | 70      | ADDR10             | 122     | FLAG2              | 174     | TDO                |
| 19      | NC                 | 71      | GND                | 123     | FLAG1              | 175     | DAI4               |
| 20      | NC                 | 72      | $V_{DDINT}$        | 124     | FLAG0              | 176     | DAI2               |
| 21      | NC                 | 73      | GND                | 125     | DAI20              | 177     | DAI3               |
| 22      | $V_{\text{DDINT}}$ | 74      | $V_{\text{DDEXT}}$ | 126     | GND                | 178     | DAI1               |
| 23      | GND                | 75      | ADDR11             | 127     | $V_{\text{DDINT}}$ | 179     | $V_{\text{DDEXT}}$ |
| 24      | $V_{\text{DDINT}}$ | 76      | ADDR12             | 128     | GND                | 180     | GND                |
| 25      | GND                | 77      | ADDR13             | 129     | $V_{\text{DDEXT}}$ | 181     | $V_{\text{DDINT}}$ |
| 26      | NC                 | 78      | GND                | 130     | DAI19              | 182     | GND                |
| 27      | DATA15             | 79      | $V_{\text{DDINT}}$ | 131     | DAI18              | 183     | DPI14              |
| 28      | DATA14             | 80      | NC                 | 132     | DAI17              | 184     | DPI13              |
| 29      | DATA13             | 81      | NC                 | 133     | DAI16              | 185     | DPI12              |
| 30      | DATA12             | 82      | GND                | 134     | DAI15              | 186     | DPI11              |
| 31      | $V_{\text{DDEXT}}$ | 83      | CLKIN              | 135     | DAI14              | 187     | DPI10              |
| 32      | GND                | 84      | XTAL               | 136     | DAI13              | 188     | DPI9               |
| 33      | $V_{\text{DDINT}}$ | 85      | $V_{\text{DDEXT}}$ | 137     | DAI12              | 189     | DPI8               |
| 34      | GND                | 86      | GND                | 138     | $V_{\text{DDINT}}$ | 190     | DPI7               |
| 35      | DATA11             | 87      | $V_{\text{DDINT}}$ | 139     | V <sub>DDEXT</sub> | 191     | $V_{\text{DDEXT}}$ |
| 36      | DATA10             | 88      | ADDR14             | 140     | GND                | 192     | GND                |
| 37      | DATA9              | 89      | GND                | 141     | $V_{\text{DDINT}}$ | 193     | $V_{\text{DDINT}}$ |
| 38      | DATA8              | 90      | $V_{\text{DDEXT}}$ | 142     | GND                | 194     | GND                |
| 39      | DATA7              | 91      | ADDR15             | 143     | DAI11              | 195     | DPI6               |
| 40      | DATA6              | 92      | ADDR16             | 144     | DAI10              | 196     | DPI5               |
| 41      | $V_{\text{DDEXT}}$ | 93      | ADDR17             | 145     | DAI8               | 197     | DPI4               |
| 42      | GND                | 94      | ADDR18             | 146     | DAI9               | 198     | DPI3               |
| 43      | $V_{\text{DDINT}}$ | 95      | GND                | 147     | DAI6               | 199     | DPI1               |
| 44      | DATA4              | 96      | $V_{\text{DDEXT}}$ | 148     | DAI7               | 200     | DPI2               |

Table 46. ADSP-21375, 208-Lead MQFP Pin Assignment (Numerically by Lead Number) (Continued)

| Pin No. | Signal      | Pin No. | Signal      | Pin No. | Signal             | Pin No. | Signal             |
|---------|-------------|---------|-------------|---------|--------------------|---------|--------------------|
| 45      | DATA5       | 97      | ADDR19      | 149     | DAI5               | 201     | CLKOUT/            |
|         |             |         |             |         |                    |         | ~RESETOUT/         |
|         |             |         |             |         |                    |         | ~RUNRSTIN          |
| 46      | DATA2       | 98      | ADDR20      | 150     | $V_{\text{DDEXT}}$ | 202     | RESET              |
| 47      | DATA3       | 99      | ADDR21      | 151     | GND                | 203     | $V_{\text{DDEXT}}$ |
| 48      | DATA0       | 100     | ADDR23      | 152     | $V_{DDINT}$        | 204     | GND                |
| 49      | DATA1       | 101     | ADDR22      | 153     | GND                | 205     | DATA30             |
| 50      | $V_{DDEXT}$ | 102     | MS1         | 154     | $V_{\text{DDINT}}$ | 206     | DATA31             |
| 51      | GND         | 103     | MS0         | 155     | GND                | 207     | DATA29             |
| 52      | $V_{DDINT}$ | 104     | $V_{DDINT}$ | 156     | $V_{\text{DDINT}}$ | 208     | $V_{DDINT}$        |

### **OUTLINE DIMENSIONS**

The ADSP-21371/ADSP-21375 is available in a 208-lead Pb-free MQFP.



2. CENTER DIMENSIONS ARE TYPICAL UNLESS OTHERWISE NOTED.
3. DIMENSIONS ARE IN MILLIMETERS AND COMPLY WITH JEDEC

STANDARD MS-029, FA-1.

Figure 40. 208-Lead Metric Quad Flat Package [MQFP] (S-208-2) Dimensions shown in millimeters

#### **ORDERING GUIDE**

| Model                            | Temperature<br>Range <sup>1</sup> | On-Chip<br>SRAM | ROM    | Operating Voltage   | Package Description | Package<br>Option |
|----------------------------------|-----------------------------------|-----------------|--------|---------------------|---------------------|-------------------|
| ADSP-21371KSZ-2B <sup>2</sup>    | 0°C to +70°C                      | 1M bit          | 4M bit | 1.2 INT V/3.3 EXT V | 208-Lead MQFP       | S-208-2           |
| ADSP-21371KSZ-2A <sup>2, 3</sup> | 0°C to +70°C                      | 1M bit          | 4M bit | 1.2 INT V/3.3 EXT V | 208-Lead MQFP       | S-208-2           |
| ADSP-21375KSZ-2B <sup>2</sup>    | 0°C to +70°C                      | 0.5M bit        | 2M bit | 1.2 INT V/3.3 EXT V | 208-Lead MQFP       | S-208-2           |

<sup>&</sup>lt;sup>1</sup> Referenced temperature is ambient temperature.

 $<sup>^2</sup>$  Z = RoHS Compliant Part

<sup>&</sup>lt;sup>3</sup> Available with a wide variety of audio algorithm combinations sold as part of a chipset and bundled with necessary software. For a complete list, visit our website at www.analog.com/SHARC

